

Dual 36V Synchronous 2A Buck LED Driver with I²C

FEATURES

- Wide Input Voltage Range: 4V to 36V
- Two Independent 2A/40V Synchronous Bucks
- I²C Interface for Internal True Color PWM™ Dimming (8192:1), Analog Dimming and Fault Reporting
- 1000:1 External True Color PWM Dimming and 10:1 External Analog Dimming
- P-Channel Metal-Oxide Semiconductor (PMOS) Switch Driver for Pulse-Width Modulators (PWM) and Output Disconnect
- ±3% Constant Current Regulation
- Adjustable Frequency: 200kHz to 2MHz
- Frequency Synchronization with Clock Output
- Programmable OPENLED Protection with Reporting
- Short-Circuit Protection with Reporting
- Programmable Undervoltage Lockout with Hysteresis
- Internal Compensation
- 9 Unique Device Addresses for I²C
- Available in 5mm × 6mm 36-pin Quad-flat no-leads (QFN) Package

APPLICATIONS

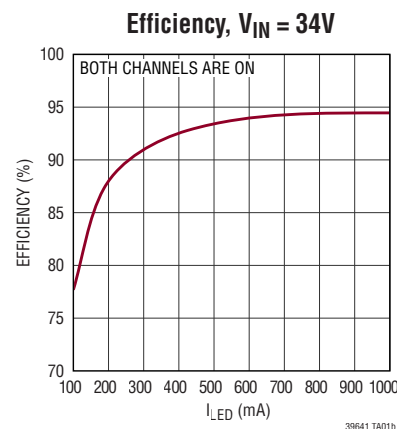
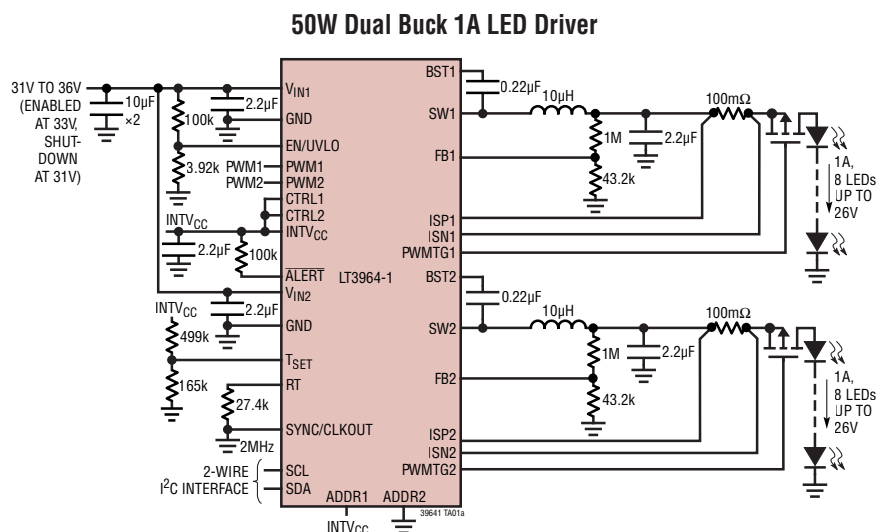
- General Purpose, Industrial, Medical and Automotive Lighting
- Constant-Current, Constant-Voltage Source

DESCRIPTION

The **LT[®]3964-1** is a dual synchronous step-down DC/DC converter with an I²C interface designed to operate as a constant-current and constant-voltage source and is ideal for driving LEDs. The fixed frequency and peak current mode topology result in stable operation over a wide range of supply and output voltages. The ground-referred voltage FB pin serves as the input for several Light Emitting Diode (LED) protection features, and allows the converter to operate as a constant-voltage source. The maximum output current is set by an external resistor, and the output current amplifier has a rail-to-rail common mode range. LT3964-1 uses an I²C interface to communicate with a microcontroller to read LED faults, write PWM and analog dimming registers and set fault masking. The I²C PWM input provides LED dimming ratios up to 8192:1. The I²C programmable CTRL register sets the gain of the external CTRL pin, and maximum current sense threshold, providing additional analog dimming capability.

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TYPICAL APPLICATION



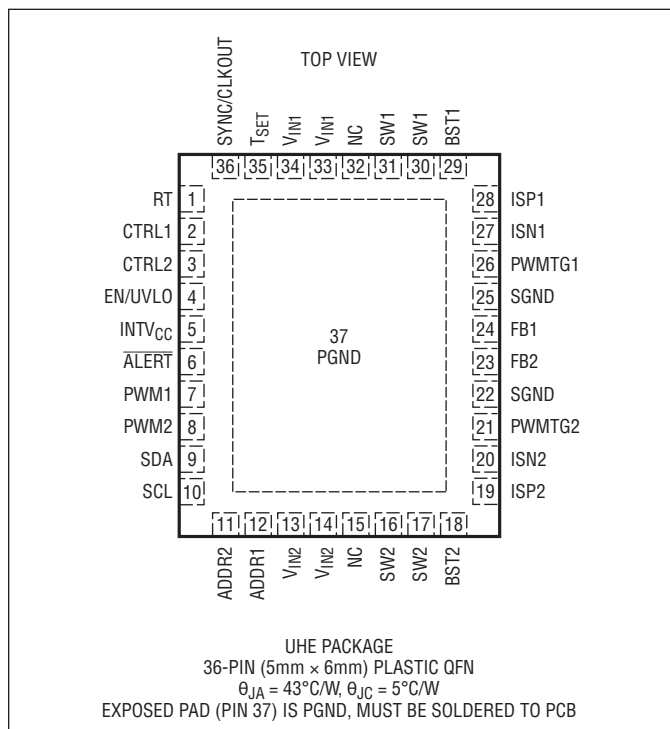
LT3964-1

ABSOLUTE MAXIMUM RATINGS

(Note 1)

V_{IN1} , V_{IN2} , EN/UVLO	40V
ISP1, ISN1, ISP2, ISN2.....	40V
PWMTG1, PWMTG2, RT	(Note 2)
SW1, SW2.....	40V
BST1, BST2.....	44.5V
BST1 to SW1, BST2 to SW2	4.5V
FB1, FB2, CTRL1, CTRL2, ADDR1, ADDR2	5V
SYNC/CLKOUT, PWM1, PWM2, T_{SET}	6V
SDA, SCL, \overline{ALERT}	6V
$INTV_{CC}$	(Note 3)
Operating Junction Temperature (Notes 4, 5)	
LT3964R-1	-40°C to 150°C
Storage Temperature Range	-60°C to 150°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3964RUHE-1#PBF	LT3964RUHE-1#TRPBF	39641	36-Pin (5mm × 6mm) Plastic QFN	-40°C to 150°C

Contact the factory for parts specified with wider operating temperature ranges.

[Tape and reel specifications](#). Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{IN1} = 12\text{V}$, $V_{EN/UVLO} = 5\text{V}$, $\text{CTRL1} = \text{CTRL2} = 2\text{V}$, $\text{PWM1} = \text{PWM2} = 2\text{V}$ unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{IN1} , V_{IN2} Operating Supply Range		●	4		36	V
V_{IN1} Pin Quiescent Current	Not Switching			2.5		mA
V_{IN1} Pin Shutdown Current	$\text{EN/UVLO} = 1.15\text{V}$, $\text{PWM1,2} = 0\text{V}$ $\text{EN/UVLO} = 0.4\text{V}$				200 4	μA μA
V_{IN2} Pin Quiescent Current	Not Switching			1	10	μA
V_{IN2} Pin Shutdown Current	$\text{EN/UVLO} = 1.15\text{V}$, $\text{PWM1,2} = 0\text{V}$ $\text{EN/UVLO} = 0.4\text{V}$				1 1	μA μA
EN/UVLO Threshold Voltage Falling		●	1.148	1.17	1.192	V
EN/UVLO Rising Hysteresis				60		mV
EN/UVLO Input Low Voltage					0.4	V
EN/UVLO Pin Bias Current Low	$\text{EN/UVLO} = 1.15\text{V}$			4		μA
EN/UVLO Pin Bias Current High	$\text{EN/UVLO} = 1.3\text{V}$			2	100	nA
Linear Regulator						
INTV_{CC} Regulation Voltage	$I_{\text{INTVCC}} = -30\text{mA}$, Not Switching	●	3.9	4	4.1	V
INTV_{CC} Line Regulation	$6\text{V} \leq V_{IN1} \leq 40\text{V}$			0.03		%/V
INTV_{CC} Load Regulation	$-30\text{mA} \leq I_{\text{INTVCC}} \leq 0\text{mA}$			0.03		%/mA
INTV_{CC} Undervoltage Lockout			3.1	3.2	3.3	V
INTV_{CC} Undervoltage Lockout Hysteresis				50		mV
INTV_{CC} Current Limit	$V_{IN1} = 12\text{V}$, $V_{\text{INTVCC}} = 3\text{V}$			110		mA
Dropout (V_{IN1} to V_{INTVCC})	$V_{IN1} = 4\text{V}$, $I_{\text{INTVCC}} = -20\text{mA}$, Not Switching			300		mV
Error Amplifier						
Full-Scale LED Current Sense Threshold ($V_{(\text{ISP1-ISN1})}$, $V_{(\text{ISP2-ISN2})}$)	$\text{ISP1,2} = 24\text{V}$, $\text{CTRL1,2} = 1.5\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{xFF}$ $\text{ISP1,2} = 0\text{V}$, $\text{CTRL1,2} = 1.5\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{xFF}$	● ●	97 96	100 100	103 104	mV mV
1/2 Scale LED Current Sense Threshold ($V_{(\text{ISP1-ISN1})}$, $V_{(\text{ISP2-ISN2})}$)	$\text{ISP1,2} = 24\text{V}$, $\text{CTRL1,2} = 0.7\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{xFF}$ $\text{ISP1,2} = 0\text{V}$, $\text{CTRL1,2} = 0.7\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{xFF}$	● ●	47 46	50 50	53 54	mV mV
1/4th Scale LED Current Sense Threshold ($V_{(\text{ISP1-ISN1})}$, $V_{(\text{ISP2-ISN2})}$) Modulated by I^2C Input $\text{ADIM1,2}[7:0]$	$\text{ISP1,2} = 24\text{V}$, $\text{CTRL1,2} = 0.7\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{x7F}$ $\text{ISP1,2} = 0\text{V}$, $\text{CTRL1,2} = 0.7\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{x7F}$	● ●	22 21	25 25	28 29	mV mV
1/10th Scale LED Current Sense Threshold ($V_{(\text{ISP1-ISN1})}$, $V_{(\text{ISP2-ISN2})}$)	$\text{ISP1,2} = 24\text{V}$, $\text{CTRL1,2} = 0.3\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{xFF}$ $\text{ISP1,2} = 0\text{V}$, $\text{CTRL1,2} = 0.3\text{V}$, $\text{ADIM1,2}[7:0] = 0\text{xFF}$	● ●	7 6	10 10	13 14	mV mV
ISP1,2/ISN1,2 Overcurrent Protection Threshold ($V_{(\text{ISP1-ISN1})}$, $V_{(\text{ISP2-ISN2})}$)	$\text{ISP1,2} = 24\text{V}$			930		mV
C/10 Current Sense Threshold ($V_{(\text{ISP1-ISN1})}$, $V_{(\text{ISP2-ISN2})}$)	$\text{ISP1,2} = 24\text{V}$ $\text{ISP1,2} = 0\text{V}$		6 6	10 11	15 16	mV mV
ISP1 , ISP2 Input Current Bias Current	$\text{PWM1,2} = 2\text{V}$ (ACTIVE) $\text{PWM1,2} = 0\text{V}$ (STANDBY)			350 5	8	μA μA
ISN1 , ISN2 Input Current Bias Current	$\text{PWM1,2} = 2\text{V}$ (ACTIVE) $\text{PWM1,2} = 0\text{V}$ (STANDBY)			30 10		μA nA
CTRL1 , CTRL2 Input Bias Current	$V_{\text{CTRL1}}, V_{\text{CTRL2}} = 1\text{V}$			20	200	nA
CTRL1 , CTRL2 PWM Shutdown Threshold		●		100	150	mV
CTRL1 , CTRL2 PWM Threshold Hysteresis				30		mV
FB1 , FB2 Regulation Voltage (V_{FB})	$\text{ISP1,2} = 24\text{V}$	●	1.163 1.17	1.18 1.18	1.197 1.19	V V
FB1 , FB2 Overvoltage Threshold			$V_{\text{FB}} + 43\text{mV}$	$V_{\text{FB}} + 53\text{mV}$	$V_{\text{FB}} + 63\text{mV}$	V

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{IN1} = 12\text{V}$, $V_{EN/UVLO} = 5\text{V}$, $\text{CTRL1} = \text{CTRL2} = 2\text{V}$, $\text{PWM1} = \text{PWM2} = 2\text{V}$ unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
FB1, FB2 OPENLED Threshold			$V_{FB} - 43\text{mV}$	$V_{FB} - 53\text{mV}$	$V_{FB} - 63\text{mV}$	V
FB1, FB2 SHORTLED Threshold		●		250	270	mV
FB1, FB2 Pin Input Bias Current	Current Out of Pin, $\text{FB} = 1\text{V}$			20	200	nA
Feedback Line Regulation	$4\text{V} \leq V_{IN1} \leq 36\text{V}$			0.001		%/V
T_{SET} Pin Voltage				630		mV
T_{SET} Pin Bias Current	Current Out of Pin, $T_{SET} = 400\text{mV}$			40	200	nA

Oscillator

RT Pin Voltage				0.96		V
Switching Frequency	$R_T = 357\text{k}$ $R_T = 60.4\text{k}$ $R_T = 27.4\text{k}$	● ● ●	184 0.93 1.84	200 1.0 2.0	218 1.07 2.18	kHz MHz MHz
SYNC/CLKOUT Pin Resistance to GND				100		k Ω
SYNC/CLKOUT Input High Threshold			1.5			V
SYNC/CLKOUT Input Low Threshold					0.4	V
SYNC/CLKOUT Output Duty Cycle	$\text{CONFIG}[6] = 1$ (Clock Output Enabled)		30	50	70	%
SYNC/CLKOUT Output Voltage High	$\text{CONFIG}[6] = 1$ (Clock Output Enabled)			4		V
SYNC/CLKOUT Output Voltage Low	$\text{CONFIG}[6] = 1$ (Clock Output Enabled)			0.1	0.3	V
SYNC/CLKOUT Output Rise Time	$C_{\text{SYNC/CLKOUT}} = 50\text{pF}$, $\text{CONFIG}[6] = 1$ (Clock Output Enabled)			40		ns
SYNC/CLKOUT Output Fall Time	$C_{\text{SYNC/CLKOUT}} = 50\text{pF}$, $\text{CONFIG}[6] = 1$ (Clock Output Enabled)			20		ns

Logic

ALERT Output Low	$I_{\text{ALERT}} = 1\text{mA}$				300	mV
PWM1, PWM2 Input High Voltage		●		1.18	1.3	V
PWM1, PWM2 Input Low Voltage		●	1.1	1.15		V
PWM1, PWM2 Resistance to GND				280		k Ω

Power Switch

Top Switch On-Resistance	$I_{\text{SW}} = 1\text{A}$			200		m Ω
Top Switch Current Limit		●	2	2.2	2.5	A
Bottom Switch On-Resistance	$I_{\text{SW}} = 1\text{A}$			180		m Ω
Bottom Switch Current Limit			1.8	2.1	2.5	A
SW Leakage Current	$V_{\text{IN}} = 36\text{V}$, $V_{\text{SW}} = 0\text{V}$, 36V		-1.5		1.5	μA
Minimum Off-Time			10	40	60	ns
Minimum ON-Time			20	40	65	ns

PWMTG Gate Driver

PWMTG ON-Voltage ($V_{\text{ISP1-PWMTG1}}$, $V_{\text{ISP2-PWMTG2}}$)	$\text{ISP1,2} = 36\text{V}$			7.5	9.5	V
PWMTG OFF Voltage ($V_{\text{ISP1-PWMTG1}}$, $V_{\text{ISP2-PWMTG2}}$)	$\text{ISP1,2} = 36\text{V}$			0	0.3	V
PWMTG Turn-On Time	$C_{\text{LOAD}} = 500\text{pF}$, $\text{ISP1,2} = 36\text{V}$			70		ns
PWMTG Turn-Off Time	$C_{\text{LOAD}} = 500\text{pF}$, $\text{ISP1,2} = 36\text{V}$			40		ns

ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{IN1} = 12\text{V}$, $V_{EN/UVLO} = 5\text{V}$, $\text{CTRL1} = \text{CTRL2} = 2\text{V}$, $\text{PWM1} = \text{PWM2} = 2\text{V}$ unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
I²C Port (Note 6)						
I ² C Address	XXXX Bits Are Programmed by ADDR[1:2]	●	110XXXX[R/W]			
V_{IHA}	High Level Input Voltage for Address Pins ADDR1, ADDR2	●	$\text{INTV}_{CC} - 0.3$			V
V_{ILA}	Low Level Input Voltage for Address Pins ADDR1, ADDR2	●	0.2			V
R_{INH}	Resistance from ADDR1, ADDR2 to INTV_{CC} to Set Chip Address Bit to 1	●	10			k Ω
R_{INL}	Resistance from ADDR1, ADDR2 to GND to Set Chip Address Bit to 0	●	10			k Ω
R_{INF}	Resistance from ADDR1, ADDR2 to GND or INTV_{CC} to Set Chip Address Bit to Float	●	1			M Ω
SDA and SCL Input High Voltage		●	1.5			V
SDA and SCL Input Low Voltage		●	0.4			V
SDA and SCL Input High Current	SDA, SCL = 3.3V		50			nA
SDA and SCL Input Low Current	Current Out of Pin, SDA, SCL = 0V		50			nA
SDA Output Low Voltage	$I_{SDA} = 3\text{mA}$		0.4			V
Clock Operating Frequency			400			kHz
Bus Free Time Between Stop and Start Condition (t_{BUF})			1.3			μs
Hold Time After Repeated Start Condition ($t_{HD,SDA}$)			0.6			μs
Repeated Start Condition Set-Up Time ($t_{SU,STA}$)			0.6			μs
Stop Condition Set-Up Time ($t_{SU,STO}$)			0.6			μs
Data Hold Time Output ($t_{HD,DAT(O)}$)			0			900 ns
Data Hold Time Input ($t_{HD,DAT(I)}$)			0			ns
Data Set-Up Time ($t_{SU,DAT}$)			250			ns
SCL Clock Low Period (t_{LOW})			1.3			μs
SCL Clock High Period (t_{HIGH})			0.6			μs
Data Fall Time	C_B = Capacitance of One Bus Line (pF)		$20 + 0.1C_B$			300 ns
Data Rise Time	C_B = Capacitance of One Bus Line (pF)		$20 + 0.1C_B$			300 ns
Input Spike Suppress Pulse Width (t_{SP})			50			ns

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Do not apply a positive or negative voltage source to the PWM1 or RT pin, otherwise permanent damage may occur.

Note 3: Do not apply a positive or negative voltage source to the INTV_{CC} pin, otherwise permanent damage may occur. $I_{\text{INTV}_{CC}} = 5\text{mA}$ is the maximum external load that can be applied. The internal load will be higher due to the power consumption of the IC.

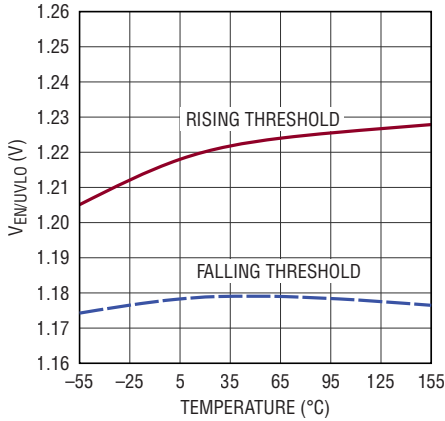
Note 4: The LT3964R-1 is guaranteed over the full -40°C to 150°C operating junction temperature range. High junction temperatures degrade operating lifetimes. Operating lifetime is derated at junction temperatures greater than 125°C .

Note 5: The LT3964R-1 includes overtemperature protection that is intended to protect the device during momentary overload conditions. The junction temperature will exceed the maximum operating junction temperature when the overtemperature is active. Continuous operating above the specified maximum operating junction temperature may impair device reliability.

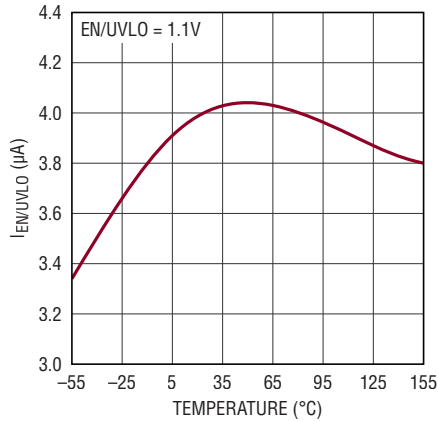
Note 6: All I²C serial port timing information is shown in Figure 16.

TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted.

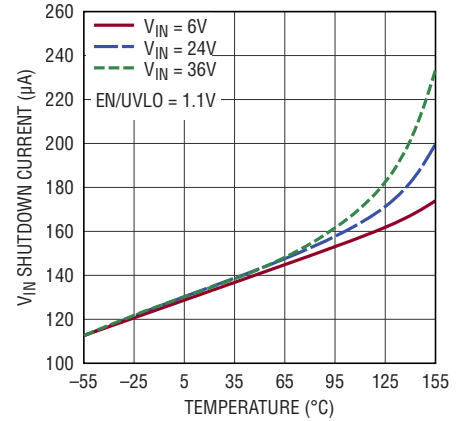
EN/UVLO Thresholds vs Temperature



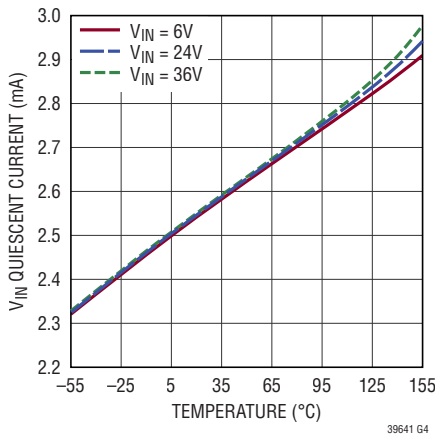
EN/UVLO Current vs Temperature



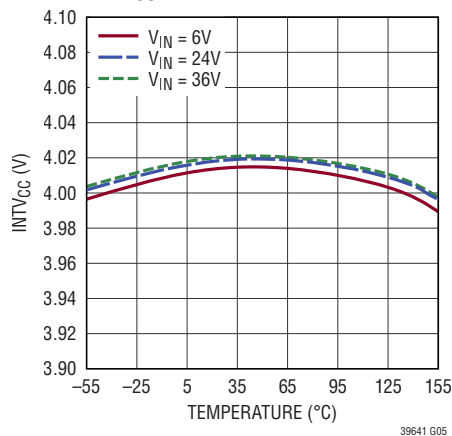
V_{IN} Shutdown Current vs Temperature



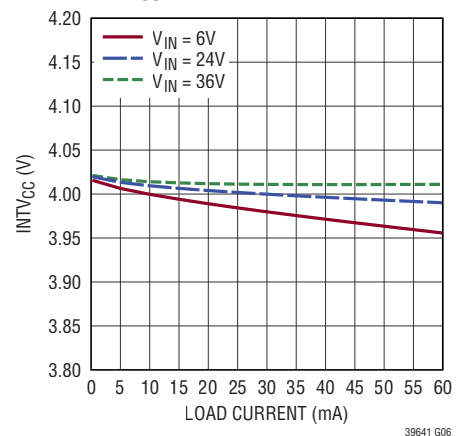
V_{IN} Quiescent Current vs Temperature



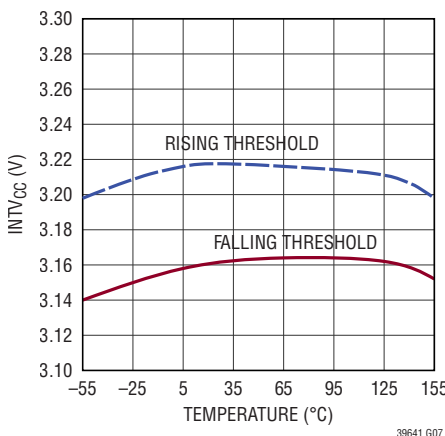
INTV_{CC} vs Temperature ($3 \cdot V_{IN}$)



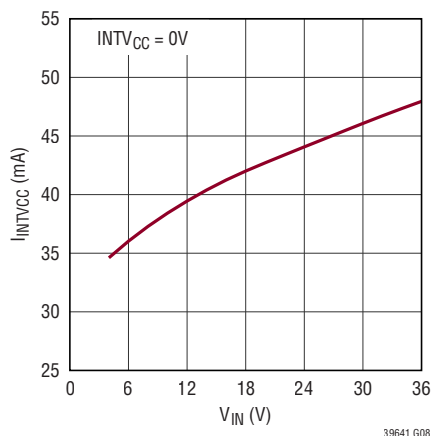
INTV_{CC} vs Current ($3 \cdot V_{IN}$)



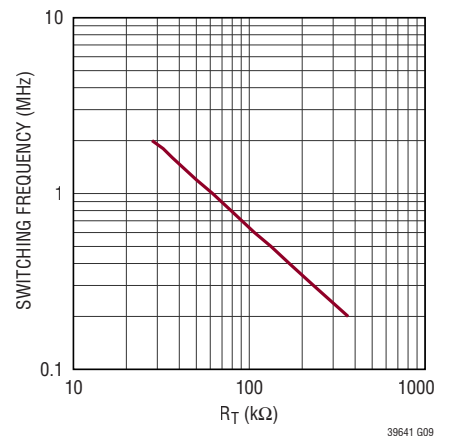
INTV_{CC} UVLO vs Temperature



INTV_{CC} Current Limit vs V_{IN}

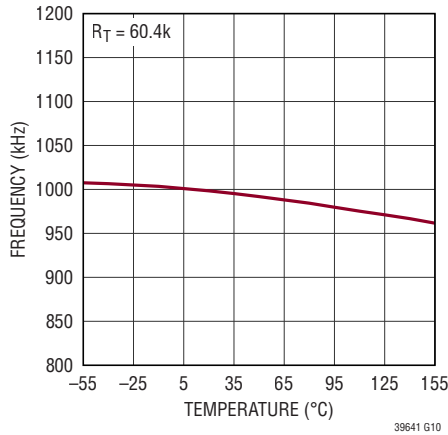


Switching Frequency vs R_T



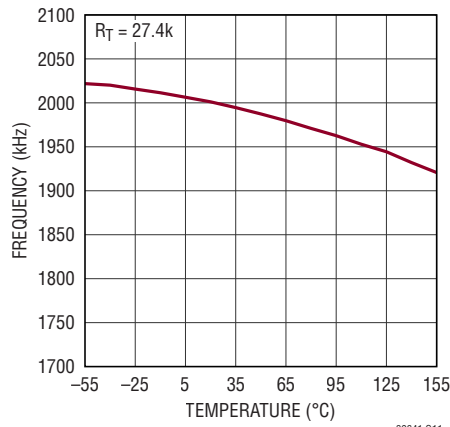
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted.

Frequency vs Temperature (1MHz)



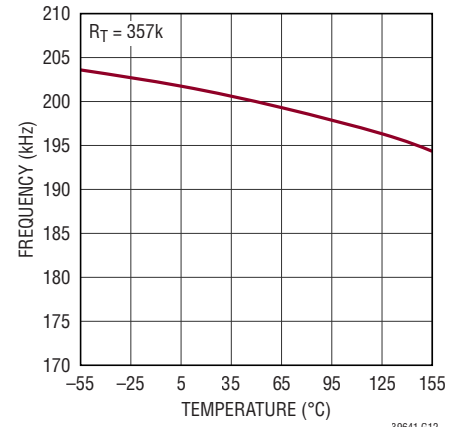
39641 G10

Frequency vs Temperature (2MHz)



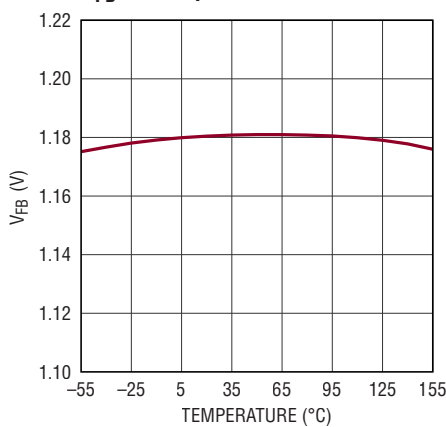
39641 G11

Frequency vs Temperature (200kHz)



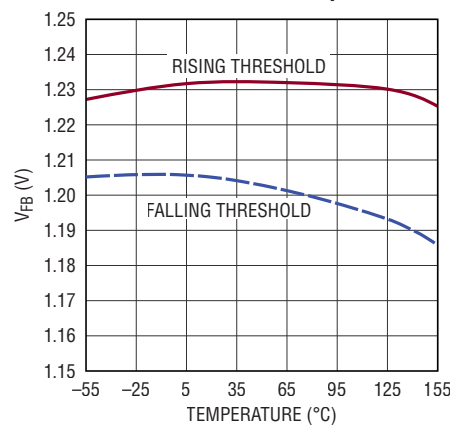
39641 G12

V_{FB} vs Temperature



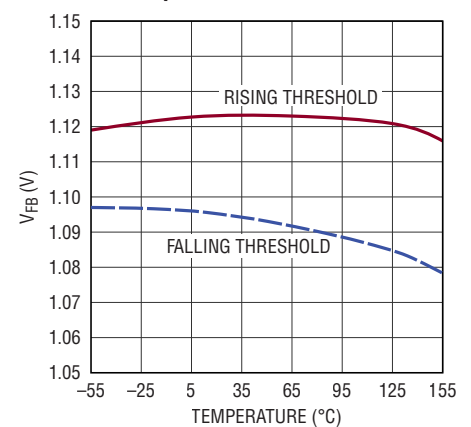
39641 G13

OVFB Threshold vs Temperature



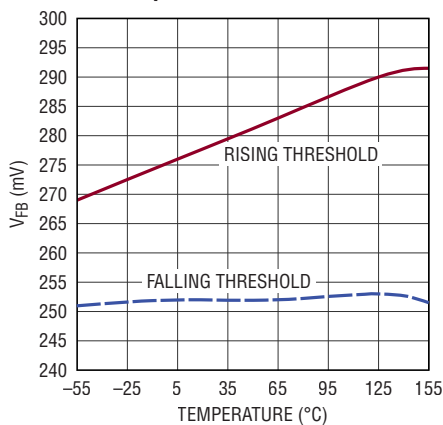
39641 G14

OPENLED Threshold vs Temperature



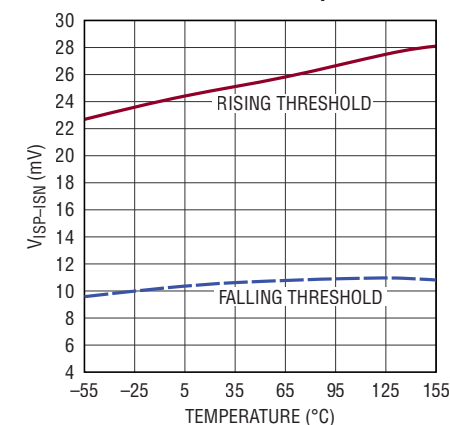
39641 G15

SHORTLED Threshold vs Temperature



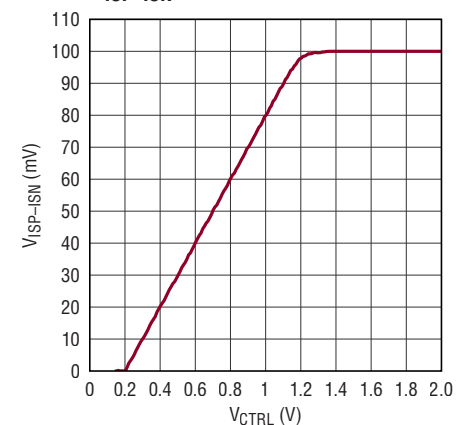
39641 G16

C/10 Threshold vs Temperature



39641 G17

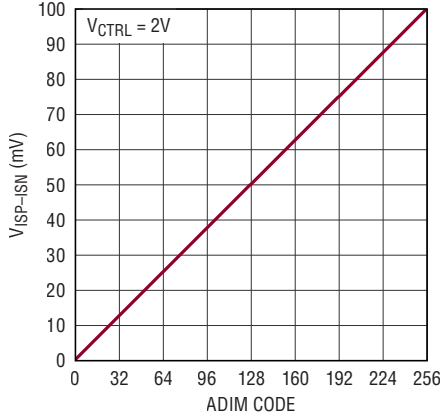
V_{SP-ISO} vs CTRL



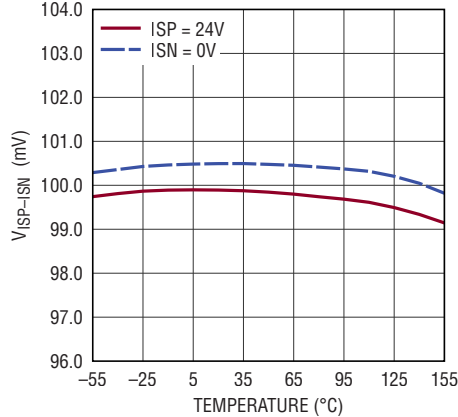
39641 G18

TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted.

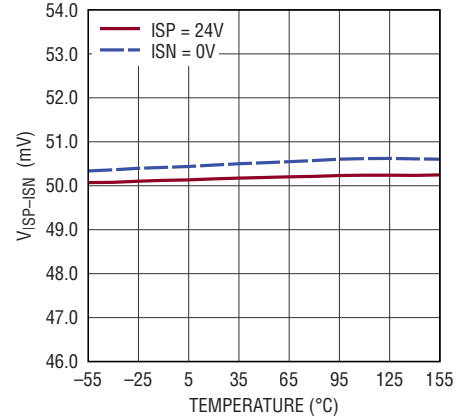
$V_{\text{ISP-ISN}}$ vs ADIM



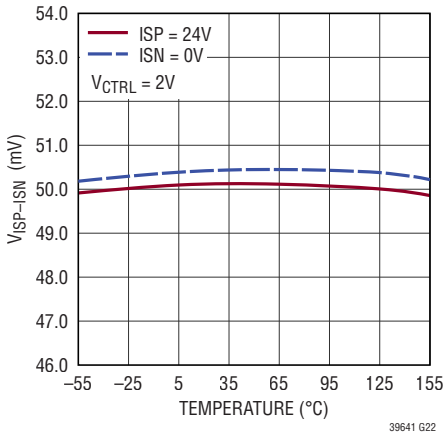
$V_{\text{ISP-ISN}}$ Full-Scale vs Temperature



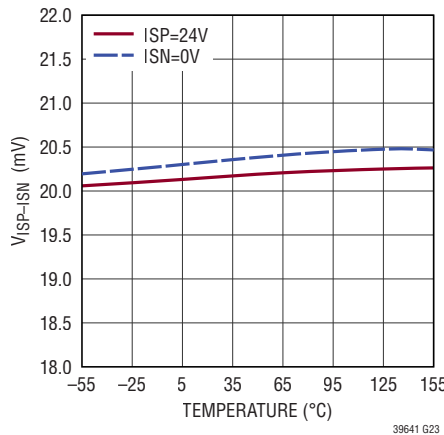
$V_{\text{ISP-ISN}}$ 1/2 Scale ($V_{\text{CTRL}} = 0.7\text{V}$) vs Temperature



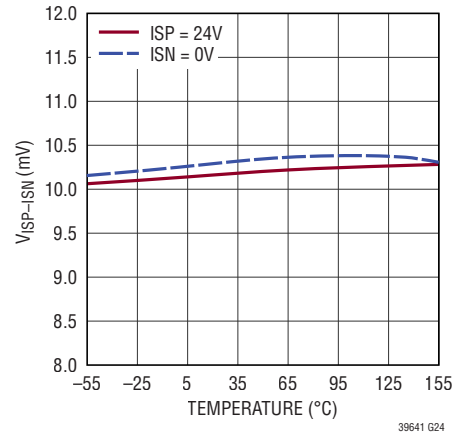
$V_{\text{ISP-ISN}}$ 1/2 Scale (ADIM = 0x7f) vs Temperature



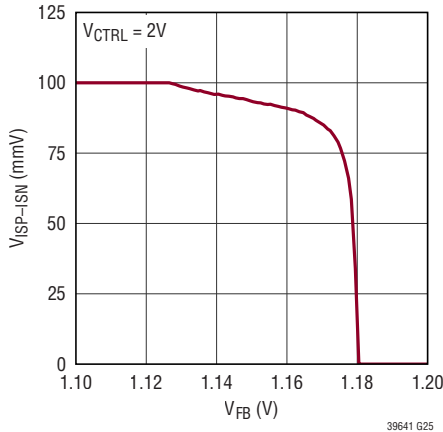
$V_{\text{ISP-ISN}}$ 1/5 Scale ($V_{\text{CTRL}} = 0.4\text{V}$) vs Temperature



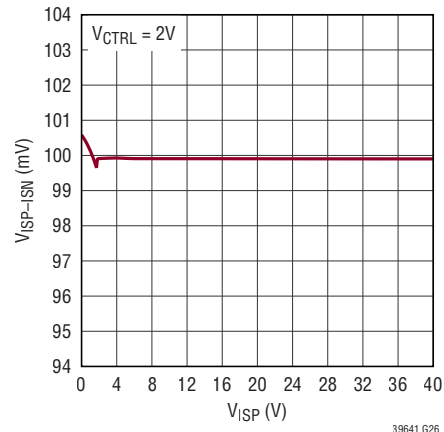
$V_{\text{ISP-ISN}}$ 1/10 Scale ($V_{\text{CTRL}} = 0.3\text{V}$) vs Temperature



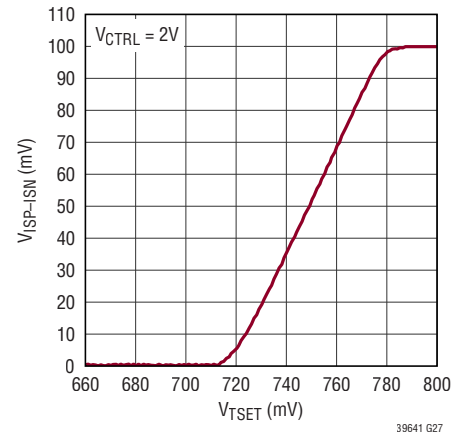
$V_{\text{ISP-ISN}}$ vs V_{FB}



$V_{\text{ISP-ISN}}$ vs V_{ISP}



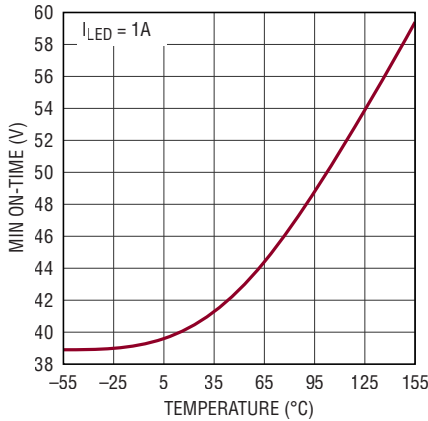
$V_{\text{ISP-ISN}}$ vs V_{TSET} at 90°C



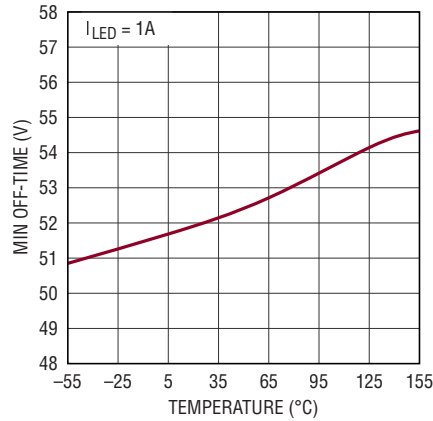
TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$, unless otherwise noted.

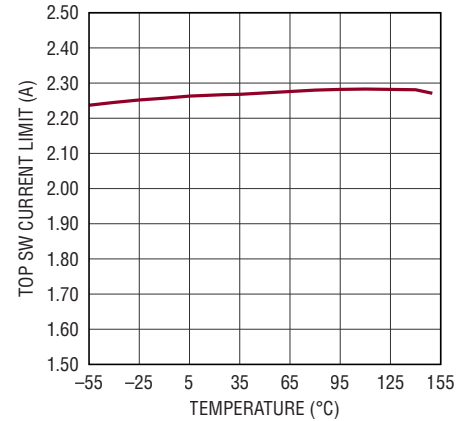
Minimum On-Time vs Temperature



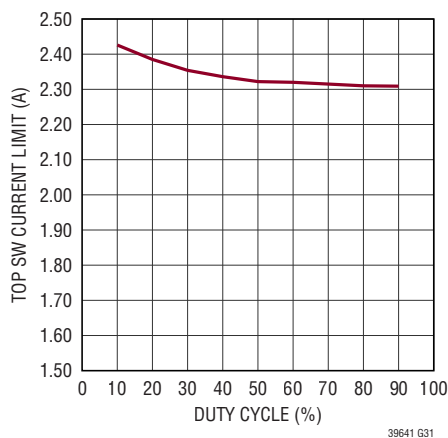
Minimum Off-Time vs Temperature



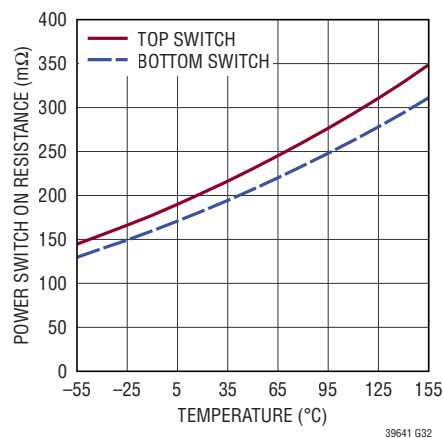
Top Switch Current Limit vs Temperature



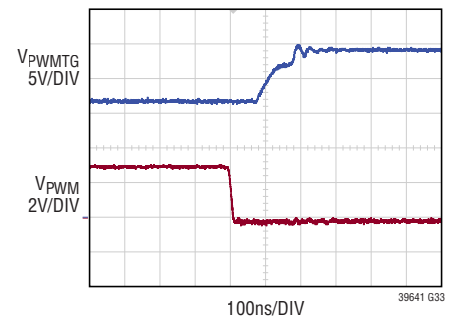
Top Switch Current Limit vs Duty Cycle



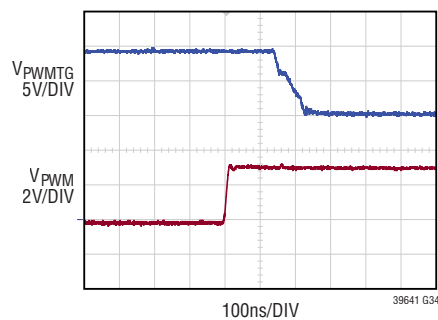
Power Switch On-Resistance vs Temperature



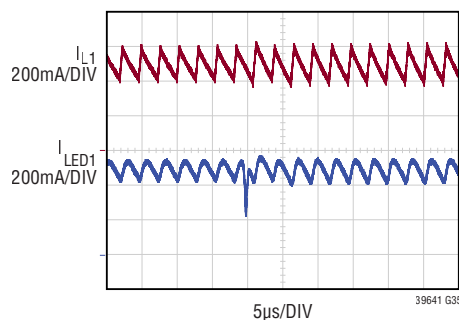
PWMTG Rising Edge



PWMTG Falling Edge

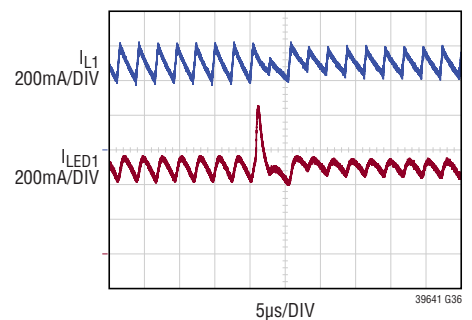


**Transient Response at $V_{IN} = 34\text{V}$
Zero LED On to One LED On**



SEE MATRIX LED DRIVER ON PAGE 31

**Transient Response at $V_{IN} = 34\text{V}$
One LED On to Zero LED On**



SEE MATRIX LED DRIVER ON PAGE 31

PIN FUNCTIONS

RT (Pin 1): Switching Frequency Adjustment Pin. Set the main clock frequency using a resistor to GND (for resistor values, see Typical Performance curve or Table 3). Do not leave the RT pin open.

CTRL1, CTRL2 (Pins 2, 3): Current Sense Threshold Adjustment Pins. The $V_{(ISP-ISN)}$ threshold is regulated by the internal 1.2V reference voltage, CTRL and ADIM[7:0] of the respective channel as follows:

$$V_{(ISP-ISN)} = 0V, \text{ when } V_{CTRL} < 0.2V$$

$$V_{(ISP-ISN)} = [(V_{CTRL} - 0.2V)/10] \cdot (ADIM[7:0] + 1)/256, \text{ when } 0.2V \leq V_{CTRL} \leq 1.1V$$

$$V_{(ISP-ISN)} = 100mV \cdot (ADIM[7:0] + 1)/256, \text{ when } V_{CTRL} > 1.3V$$

For $1.1V < V_{CTRL} < 1.3V$, the dependence of the current sense threshold upon V_{CTRL} transitions from a linear function to a constant value, reaching 98% of full-scale value, $100mV \cdot (ADIM[7:0] + 1)/256$, by $V_{CTRL} = 1.2V$. See Table 1 for detailed information. Do not leave this pin open.

EN/UVLO (Pin 4): Enable and Undervoltage Lockout Pin. An accurate 1.18V falling threshold with externally programmable hysteresis detects when power is OK to enable switching. Rising hysteresis is generated by the external resistor divider and an accurate internal 4 μ A pull-down current. Tie to 0.4V or less to disable the device.

INTV_{CC} (Pin 5): Internal Low-Dropout Regulator Output. INTV_{CC} is regulated to 4V, and must be bypassed with an external capacitor of at least 2.2 μ F. INTV_{CC} is the power supply for the internal double diffusion metal oxide semiconductor (DMOS) gate driver and control circuitry. Users may apply <5mA loads to INTV_{CC}. Overloading INTV_{CC} can cause unintentional device shutdown from INTV_{CC} current limiting or overheating due to power dissipation.

ALERT (Pin 6): Chip Alert Status Report Pin. An open-collector pull-down on \overline{ALERT} asserts when any of the following conditions happen:

1. FB Overvoltage ($V_{FB} > 1.233V$);
2. OPENLED ($V_{FB} > 1.127V$ and $V_{(ISP-ISN)} < 10mV$);
3. SHORTLED ($V_{FB} < 0.25V$);
4. LED Overcurrent ($V_{(ISP-ISN)} > 930mV$);
5. INTV_{CC} undervoltage; or
6. Thermal shutdown.

\overline{ALERT} flag stays low until all alerts have been removed and unlatched.

PWM1, PWM2 (Pins 7, 8): PWM Input Signal Pin. A low signal turns off switching, reduces quiescent supply current, and drives PWMTG to the ISP level. PWM has an internal 280k pull-down resistor. If not used, connect this pin to INTV_{CC}.

SDA (Pin 9): Serial Data Line for I²C Port. Open-drain output during read back.

SCL (Pin 10): Serial Clock Line for I²C Port.

ADDR2 (Pin 11): Address Select Pin. This pin is configured as a three-state (LOW, HIGH, FLOAT) address control bit for the device I²C address. See Table 12 for address selection.

ADDR1 (Pin 12): Address Select Pin. This pin is configured as a three-state (LOW, HIGH, FLOAT) address control bit for the device I²C address. See Table 12 for address selection.

V_{IN2} (Pins 13, 14): Input Supply for Channel 2. May be driven by an independent supply, or connected to V_{IN1}. This signal must be locally bypassed. Be sure to place the positive terminal of the input capacitor as close as possible to the V_{IN2} pin, and the negative terminal as close as possible to the PGND pin (Pin 37).

PIN FUNCTIONS

SW1, SW2 (Pins 16, 17, 30, 31): SW Pins. The SW pins are the outputs of the internal power switches of each channel. Tie each channel SW pins together and connect them to the appropriate inductor and boost capacitor. These nodes should be kept small on the PCB for good performance.

BST1, BST2 (Pins 18, 29): Boost Pins. These pins are used to provide a drive voltage, higher than the input voltage, to the topside power switch of each channel. Place a 0.1 μ F or larger boost capacitors as close as possible to the IC.

ISP1, ISP2 (Pins 19, 28): Connection Points for the Positive Terminals of the Current Feedback Resistors ($R_{LED1,2}$). It also serves as positive rails for PWMGTG drivers.

ISN1, ISN2 (Pins 20, 27): Connection Points for the Negative Terminals of the Current Feedback Resistors ($R_{LED1,2}$).

PWMTG1, PWMTG2 (Pins 21, 26): Top Gate Driver Outputs. An inverted and level-shifted version of the PWM input signals. Used to drive the gate of an external PMOS transistor between V_{ISP} and $V_{ISP} - 7.5V$ to provide load-side on/off control, PWM dimming and fault-mode disconnect. Leave PWMTG unconnected if not used.

FB1, FB2 (Pins 23, 24): Voltage Loop Feedback Pins. The FB pin is intended for constant-voltage regulation or for LED protection/OPENLED detection. The LT3964-1 regulates the FB pins to 1.18V(NOMINAL). If the FB input is regulating the loop and $V_{(ISP-ISN)}$ is less than 10mV (Typical), the corresponding OPENLED bit in the chip status register is set, and the \overline{ALERT} pull-down is asserted. This action may signal an OPENLED fault for that channel. If FB is driven above 1.233V, the power switches are turned off for that channel, the corresponding OVFB bit in the chip status register is set, \overline{ALERT} pull-down is asserted, and the PWMTG pin for that channel is driven high to protect the LEDs from an overcurrent event. If FB is driven below 0.25V, the power switches are turned off for that channel, the corresponding SHORTLED bit in the

chip status register is set, \overline{ALERT} pull-down is asserted, and the PWMTG pin for that channel is driven high to isolate the LED string from the power path. Do not tie these pins to GND.

V_{IN1} (Pins 33, 34): Input Supply. The V_{IN1} pins supply current to the LT3964-1 internal circuitry and to the internal topside power switch of Channel 1. This pin must be locally bypassed. Be sure to place the positive terminal of the input capacitor as close as possible to the V_{IN1} pins, and the negative terminal as close as possible to the PGND pin (Pin 37).

T_{SET} (Pin 35): Junction Temperature Adjustment Pin. Programs LT3964-1 junction temperature breakpoint, beyond which LED currents will begin to decrease. An internal V_{PTAT} threshold (see Block Diagram) increases with junction temperature. When V_{PTAT} exceeds T_{SET} pin voltage, LED currents are decreased. If the function is not required, connect the T_{SET} pin to the INTV_{CC} pin.

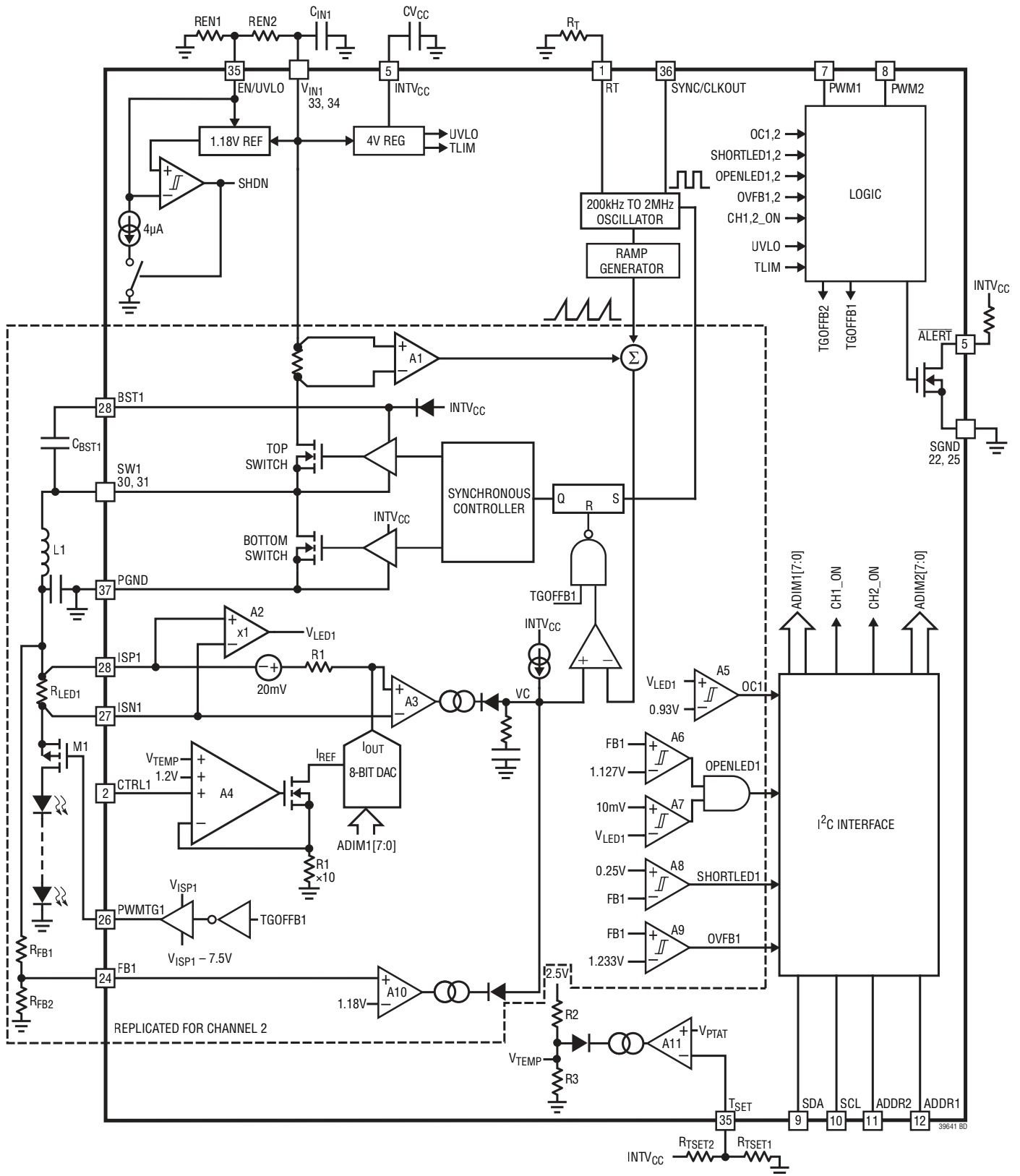
SYNC/CLKOUT (Pin 36): The SYNC/CLKOUT pin can be used to synchronize the internal oscillator to an external logic level signal. The R_T resistor should be chosen to program an internal switching frequency 10% slower than the SYNC pulse frequency. Use a 50% duty cycle waveform to drive this pin. When CONFIG[6] bit in the chip configuration register is set, a buffered version of the clock signal is driven out of the SYNC/CLKOUT pin. Note that the SYNC/CLKOUT pin is only meant to drive capacitive loads up to 50pF. If not used, tie this pin to GND with a 20k resistor.

SGND (Pins 22, 25): Chip Ground Pin.

PGND (Pin 37): Power Switch Ground. These pins are the return path of the internal bottom-side power switch. Place the negative terminal of the input capacitor as close to the PGND pins as possible.

NC (Pins 15, 32): No Connect Pin.

BLOCK DIAGRAM



OPERATION

The LT3964-1 is a dual constant-frequency, current mode step-down DC/DC converter with internal synchronous power switches. The operation of the LT3964-1 is best understood by referring to the Block Diagram of the IC.

In normal operation, with the PWM pin is low or CH1,2_ON signal is low, TGOFFB is disabled. The power switches are turned off, the PWMTG pin is pulled high to ISP to turn off the PMOS disconnect switch, and the ISP and ISN pin bias currents are reduced to several μA . When the PWM pin and CH1,2_ON signal transitions high, the PWMTG pin transitions low after a short delay. At the same time, the bottom switch is turned on for a short period of time to refresh the boost capacitor, followed by the top power switch turning on. A voltage input proportional to the top switch current is added to a stabilizing slope compensation ramp, and the resulting top switch current sense signal is fed into the negative terminal of the PWM comparator. The current in the external inductor increases steadily during the time the top switch is on. When the switch current sense voltage exceeds the output of the error amplifier, labeled VC, the latch is reset, and the switch is turned off. During the top switch-off phase, the synchronous bottom switch is on until the next clock cycle begins or the inductor current falls to zero. If overload conditions result in more than 2.1A (Typ) flowing through the bottom switch, the next clock cycle will be delayed until the switch current returns to a safe level. At the completion of each oscillator cycle, internal signals such as slope compensation return to their starting points, and a new cycle begins with the set pulse from the oscillator. Through this repetitive action, the PWM control algorithm establishes a switch duty cycle to regulate a current or voltage in the load. The VC signal is integrated over many switching cycles and is an amplified version of the difference between the LED current sense voltage, measured between ISP and ISN, and the target difference voltage set by the CTRL pin and I²C input ADIM[7:0]. In this manner, the error amplifier sets the correct top switch peak current level to keep the LED current in regulation. If the error amplifier output increases, more current is demanded in the switch; if it decreases, less current is demanded. The analog input at the CTRL pin together with the digital input ADIM[7:0] can be used to provide a combination of temperature foldback protection via CTRL and analog dimming via I²C, or a combination of analog dimming via CTRL pin and LED binning via I²C.

In voltage feedback mode, the operation is similar to that described above, except the voltage at the VC node is set by the amplified difference of the internal reference of 1.18V (typical) and the FB pin. If FB is lower than the reference voltage, the top switch current increases; if FB is higher than the reference voltage, the top switch demand current decreases. The LED current sense feedback interacts with the voltage feedback so that FB does not exceed the internal reference and the voltage between ISP and ISN does not exceed the threshold set by the product of the analog input at CTRL pin and the digital input ADIM[7:0] through I²C. For accurate current or voltage regulation, it is necessary to ensure that under normal operating conditions, the appropriate loop is dominant. To deactivate the voltage loop entirely, FB can be set between 0.3V and 1.08V through a resistor network to the INTV_{CC} pin. To deactivate the LED current loop entirely, the ISP and ISN should be tied together and CTRL tied to INTV_{CC}.

Two LED specific functions featured on the LT3964-1 are controlled by the voltage feedback FB pin. First, when the FB pin exceeds a voltage 53mV lower (–4%) than the FB regulation voltage and $V_{(ISP-ISN)}$ is less than 10mV (Typical), the OPENLED bit, STATUS[1] or STATUS[5], is set in the channel status register. This function provides a status indicator that the load may be disconnected and the constant-voltage feedback loop is taking control of the switching regulator. When the FB pin drops below 0.25V (typical) after start-up, the SHORTLED bit, STATUS[2] or STATUS[6], is set by comparator A8. A blanking period occurs during start-up for the SHORTLED protection feature from the EN/UVLO toggle.

LT3964-1 features a PMOS disconnect switch driver. The PMOS disconnect switch can be used to improve the PWM dimming ratio, and operate as fault protection as well. Once a fault condition is detected, the PWMTG pin is pulled high to turnoff the PMOS switch. The action isolates the LED array from the power path, preventing excessive current from damaging the LEDs.

The I²C interface is used to communicate between LT3964-1 and a microprocessor. LT3964-1 receives digital PWM dimming and analog dimming commands from a microprocessor and sends back the chip status, i.e., FB overvoltage ($\text{FB} > 1.233\text{V}$), output short ($\text{FB} < 0.25\text{V}$) after start-up, LED overcurrent ($V_{(ISP-ISN)} > 930\text{mV}$), OPENLED ($\text{FB} > 1.127\text{V}$ and $V_{(ISP-ISN)} < 10\text{mV}$).

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The following is a guide to selecting the external components and configuring the LT3964-1 according to the requirements of an application.

OPERATION MODE

The LT3964-1 has two operation modes: I²C mode (at least one address pin is NOT grounded) and non-I²C mode (both I²C address pins are grounded, i.e. ADDR1 = ADDR2 = GND).

In I²C mode, the LT3964-1 is initially set to be idle after power on reset. It will stay in idle until an updated PWM command is received via I²C interface.

In non-I²C mode, the LT3964-1 starts up right after the PWM pin input signal rising edge after power-on reset. Non-I²C mode allows customers to access all the registers using the chip address (1100000 R/W).

PROGRAMMING LED CURRENT WITH THE CTRL PIN

The LED current is programmed by placing an appropriate value current sense resistor R_{LED} between the ISP and ISN pins. For best fault protection provided by the high side PMOS disconnect switch, sensing of the current should be done at the top of the LED string. The LED current is regulated by the internal 1.2V reference voltage, analog input at CTRL and digital input ADIM[7:0] of analog dimming register (Equation 1).

$$I_{LED} = \frac{100\text{mV}}{R_{LED}} \cdot \frac{ADIM[7:0]+1}{256}, V_{CTRL} > 1.3\text{V}$$

$$I_{LED} = \frac{V_{CTRL}-0.2\text{V}}{10 \cdot R_{LED}} \cdot \frac{ADIM[7:0]+1}{256}, 0.2\text{V} < V_{CTRL} < 1.1\text{V} \quad (1)$$

$$I_{LED} = 0, V_{CTRL} < 200\text{mV}$$

When the CTRL pin voltage is between 1.1V and 1.3V, the LED current varies with CTRL, but departs from Equation 1 by an increasing amount as the CTRL voltage increases. Ultimately, above 1.3V, the LED current no longer varies with CTRL. The typical $V_{(ISP-ISN)}$ threshold vs CTRL in terms of ADIM[7:0] is listed in Table 1.

Table 1. $V_{(ISP-ISN)}$ Threshold vs CTRL in Terms of ADIM[7:0]

$V_{CTRL}(\text{V})$	$V_{(ISP-ISN)}(\text{mV})$
1.1	$90 \cdot (ADIM[7:0]+1)/256$
1.15	$94.4 \cdot (ADIM[7:0]+1)/256$
1.2	$97.8 \cdot (ADIM[7:0]+1)/256$
1.25	$99.4 \cdot (ADIM[7:0]+1)/256$
1.3	$100 \cdot (ADIM[7:0]+1)/256$

The CTRL pin should not be left open (tie to INTV_{CC} if not used). CTRL can also be used in conjunction with a thermistor to provide overtemperature protection for the LED load as shown in Figure 1, or with a resistor divider to V_{IN} to reduce output power and switching current when V_{IN} is low.

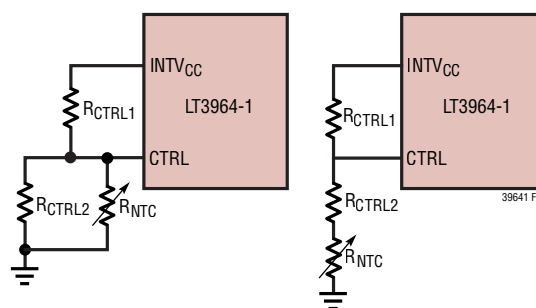


Figure 1. Setting CTRL with NTC Resistors

The digital input ADIM[7:0] of analog dimming register shown in Table 2 can be accessed via I²C, which provides additional analog dimming. The default power-on value is 255.

The presence of a time varying differential voltage signal (ripple) across ISP and ISN at the switching frequency is expected. The amplitude of this signal is increased by high LED load current, low switching frequency and/or a smaller value output filter capacitor. For best accuracy, the amplitude of this ripple should be less than $\pm 5\text{mV}$.

SETTING SWITCHING FREQUENCY WITH THE RT PIN

The RT frequency adjust pin allows the user to program the switching frequency from 200kHz to 2MHz to optimize efficiency/performance or external component size. Higher frequency operation yields smaller component size but increases switching losses, and may not allow

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sufficiently high or low duty cycle operation. Lower frequency operation gives better performance at the cost of larger external component size. For an appropriate R_T resistor value see Table 3. An external resistor from the RT pin to GND is required—do not leave this pin open.

Table 2. Channel 1 Analog Dimming Register

ANALOG DIMMING REGISTER[BIT]	VALUE	SETTING
ADIM1[0]	0 1*	0 +1/256 of the Current Set by CTRL
ADIM1[1]	0 1*	0 +1/128 of the Current Set by CTRL
ADIM1[2]	0 1*	0 +1/64 of the Current Set by CTRL
ADIM1[3]	0 1*	0 +1/32 of the Current Set by CTRL
ADIM1[4]	0 1*	0 +1/16 of the Current Set by CTRL
ADIM1[5]	0 1*	0 +1/8 of the Current Set by CTRL
ADIM1[6]	0 1*	0 +1/4 of the Current Set by CTRL
ADIM1[7]	0 1*	0 +1/2 of the Current Set by CTRL

*Denotes Default Power-On Value.

Table 3. R_T Resistance Range

SWITCHING FREQUENCY	R_T (k Ω)
2MHz	27.4
1.8MHz	32.4
1.6MHz	36.5
1.4MHz	42.2
1.2MHz	49.9
1MHz	60.4
800kHz	78.7
600kHz	107
400kHz	169
500kHz	133
300kHz	232
200kHz	357

FREQUENCY SYNCHRONIZING AND CLOCK

The LT3964-1 switching frequency can be synchronized to an external clock using the SYNC/CLKOUT pin. For

proper operation, the R_T resistor should be chosen for a switching frequency 10% lower than the external clock frequency. Observation of the following guidelines about the SYNC waveform will ensure proper operation of this feature. Driving SYNC/CLKOUT with a 50% duty cycle waveform is always a good choice, otherwise, maintain the duty cycle between 20% and 60%. If the SYNC/CLKOUT pin is not used, it should be connected to GND through a 20k resistor or left floating (an internal 100k connects their pin to GND).

CLOCK SYNCHRONIZATION OF ADDITIONAL REGULATORS

The SYNC/CLKOUT pin of the LT3964-1 can be used to synchronize one or more other compatible switching regulator ICs. The frequency of the main LT3964-1 is set by the external R_T resistor, and the RT pin of all subordinate ICs must have a resistor tied to ground. It is preferable for all subordinate ICs to have the same internal free-running frequency. This CLKOUT function is disabled initially after power on reset. To enable this function, CONFIG[6] in the main LT3964-1's chip configuration register (see Table 11), has to be set to logic high via I²C interface. Note that the SYNC/CLKOUT pin is only meant to drive capacitive loads up to 50pF.

UNDERSTANDING THE CURRENT LIMIT

The LT3964-1 has a peak current limit of 2.2A (typical). The inductor current, however, may exceed 2.2A when the frequency is high and the output voltage is low as in a short-circuit. This is because there is a minimum on-time for which the SW pin will be driven high each switching period. The inductor current increases during this time, and if the frequency is high and the output voltage low, there may not be enough off-time remaining in each switching period for the inductor current to decrease back to the level at which it started. In this case, the net inductor current would increase with each switching period regardless of the state of the CTRL pin. To prevent an unbounded inductor current that would damage the LT3964-1, the on-time is prohibited until the current decreases to less than the valley current limit (2.1A typical).

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The peak current may increase to 2.2A (typical), but the off-time and the switching period are extended until the inductor current reaches equilibrium.

The above scenario generally ensues only when the output voltage is shorted to ground. When instead the LED string is shorted to ground, the voltage across the external PWM TG MOSFET (described later) is often high enough that the required on-time is greater than the minimum on-time. This means the inductor current can remain regulated even at the highest switching frequency.

SELECTING AN INDUCTOR

The LT3964-1 is designed to minimize solution size by allowing the inductor to be chosen based on the output load requirements of the application. The inductor must be rated for the current limit regardless of the intended application.

In applications with 1μF or larger output filter cap and fixed output load, a good first choice of inductor is given by Equation 2.

$$L = \frac{V_{OUT}}{1.2A \cdot f_{SW}} \quad (2)$$

In Equation 2, V_{OUT} is the output voltage, and f_{SW} is the switching frequency.

To avoid overheating and poor efficiency, an inductor must be chosen with an RMS current rating that is greater than the maximum expected output load of the application. In addition, the saturation current (typically labeled I_{SAT}) rating of the inductor must be higher than the load current plus 1/2 of the inductor ripple current given by Equation 3.

$$I_{PEAK} = I_{LOAD(MAX)} + \frac{1}{2} \Delta I_L \quad (3)$$

where $I_{LOAD(MAX)}$ is the maximum output load for a given application, and ΔI_L is the inductor ripple current as calculated in Equation 4.

$$\Delta I_L = \frac{V_{OUT}}{L \cdot f_{SW}} \left(1 - \frac{V_{OUT}}{V_{IN(MAX)}} \right) \quad (4)$$

In applications that have dynamic and time-varying output loads, there is usually no output capacitor. The input voltage of these applications is fixed and generated from a boost converter. The inductor ripples must be limited to meet EMI requirements. For a given inductor ripple ΔI_L , the inductor should be selected with Equation 5.

$$L = \frac{V_{IN}}{4 \cdot \Delta I_L \cdot f_{SW}} \quad (5)$$

The optimum inductor for a given application may differ from the one indicated by this design guide. A larger value inductor provides a higher maximum load current and reduces the output voltage ripple. For applications requiring a high PWM dimming ratio, the value of the inductor may be lower. But be aware that the low inductance may result in discontinuous mode operation. The manufacturers featured in Table 4 are recommended sources of inductors.

Table 4. Inductor Manufacturers

MANUFACTURER	WEBSITE
Würth Elektronik	www.we-online.com
Coilcraft	www.coilcraft.com
Vishay Inter Technology	www.vishay.com

SELECTING AN OUTPUT CAPACITOR

In applications with fixed LED load, the output capacitor has two essential functions. It is first responsible for filtering the inductor current ripple so that the LED current will have relatively little ripple. It also stabilizes the LT3964-1's current loop, since the LED string impedance and output capacitor form the 2nd dominating pole in the loop, usually between 10kHz and 40kHz. Ceramic capacitors have very low equivalent series resistance (ESR) and provide the best ripple performance. The sizing of the output capacitor depends on the chosen switching frequency, the inductor value and the equivalent LED string impedance. Use of an X7R or X5R type ceramic capacitor is recommended. For good starting values, see the Typical Application section. Consult factory applications for more detailed information.

When choosing a capacitor, special attention should be given to calculate the effective capacitance under the

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PROGRAMMING INPUT UNDERVOLTAGE LOCKOUT

The LT3964-1 will stop switching and disable the PWMGTG driver when the voltage at the EN/UVLO pin drops below precisely 1.18V, but internal circuitry will continue drawing current. A small 4μA pull-down current is active when EN/UVLO is below this threshold. Full shutdown is guaranteed when EN/UVLO is below 0.4V, and in full shutdown, the LT3964-1 will draw less than 1μA.

An external voltage source can be used to set the voltage at EN/UVLO and enable or disable the LT3964-1 at will. Alternatively, a resistor network can be placed between V_{IN} and EN/UVLO, as shown in Figure 3. Equation 6 should be used to determine the values of the resistor.

$$V_{IN(FALLING)} = 1.18V \cdot \frac{R_{EN1} + R_{EN2}}{R_{EN1}} \quad (6)$$

$$V_{IN(RISING)} = 1.23V \cdot \frac{R_{EN1} + R_{EN2}}{R_{EN1}} + 4\mu A \cdot R_{EN2}$$

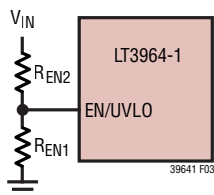


Figure 3. EN/UVLO Resistor Configuration

USING THE T_{SET} PIN FOR THERMAL PROTECTION

The LT3964-1 contains a special programmable thermal regulation loop that limits the internal junction temperature of the part. This thermal regulation feature provides important protection at high ambient, and allows a given application to be optimized for typical, not worst-case, ambient temperatures with the assurance that the LT3964-1 will automatically protect itself and the LED strings under worst-case conditions.

The operation of the thermal loop is simple. As the ambient temperature increases, so does the internal junction temperature is reached, the LT3964-1 begins to linearly reduce the LED current, as needed, to try and maintain this temperature. This can only be achieved when the ambient

temperature stays below the desired maximum junction temperature. If the ambient temperature continues to rise past the programmed maximum junction temperature, the LEDs current will be reduced to approximately zero.

While this feature is intended to directly protect the LT3964-1, it can also be used to derate the LED current at high temperatures. Since there is a direct relationship between the LED current and LT3964-1 junction temperature, the T_{SET} function also provides some LED current derating at high temperatures.

Two external resistors program the maximum IC junction temperature using a resistor divider from the $INTV_{CC}$ pin, as shown in Figure 4. Choose the ratio R_{TSET1} and R_{TSET2} for the desired junction temperature. Figure 5 shows the relationship of T_{SET} voltage to junction temperature.

A 10nF capacitor in parallel with R_{TSET1} is recommended if the T_{SET} node picks up switching noise due to bad Printed Circuit Board (PCB) layout practice.

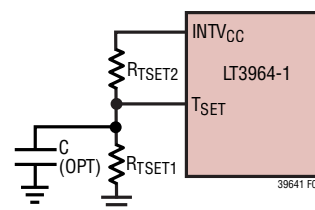


Figure 4. Programming the T_{SET}

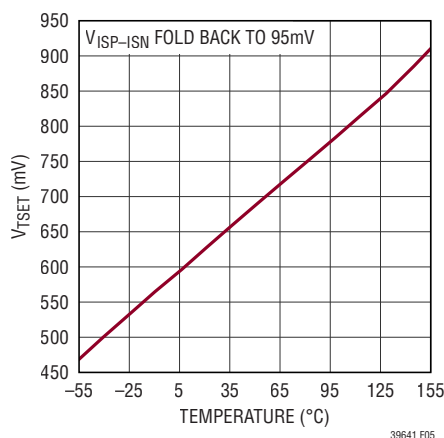


Figure 5. T_{SET} Pin Threshold vs Junction Temperature

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SELECTING A MOSFET FOR PWM DIMMING

Pulse-width-modulation of the LED current is an effective way to control the brightness of the light without varying its color. The brightness can also be adjusted with finer resolution this way than by varying the current level.

The LT3964-1 features a PWMGTG driver that is intended for a high-voltage P-channel metal oxide semiconductor (PMOS) switch in position to effect Pulse width modulated (PWM) dimming by connecting and disconnecting the string of LEDs from the output capacitor and the current sense resistor. When the switch is open, and the string is disconnected, the LED current will be zero. In contrast to a low-side N-channel metal-oxide semiconductor (NMOS) driver, this feature eliminates the need for a dedicated return path for the LED current in automotive applications or other grounded-chassis systems.

A high-side PMOS disconnected switch with a minimum V_{TH} of $-1V$ to $-2V$ is recommended in most LT3964-1 applications. The drain-source voltage rating of the chosen PMOS should be greater than the maximum output voltage set by the FB pin, and the ID rating should be above I_{LED} . A diode with an anode connected to the ground and a cathode to the drain of the PWMGTG Metal-oxide-semiconductor field-effect transistor (MOSFET) as D1 shown in Figure 6 can protect that device from overvoltage caused by excessive inductance in the LED string. Table 6 lists three recommended manufacturers of PMOS devices.

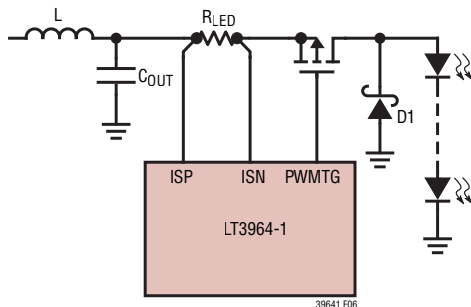


Figure 6. Catch Diode for Short-Circuit Protection with Disconnect PMOS

Table 6. PMOS Manufacturers

MANUFACTURER	WEBSITE
Infineon Technologies	www.infineon.com
Vishay Inter Technology	www.vishay.com
Renesas Electronics	www.am.renesas.com

PROGRAMMING OUTPUT VOLTAGE (CONSTANT-VOLTAGE REGULATION) OR OUTPUT CLAMP

For applications that have fixed LED loads and output capacitor, the LT3964-1's voltage feedback pin FB can be used to program the OPENLED clamp voltage by selecting the values of R_{FB1} and R_{FB2} (see Figure 7) according to Equation 7.

$$V_{OUT} = 1.18V \cdot \frac{R_{FB1} + R_{FB2}}{R_{FB1}} \quad (7)$$

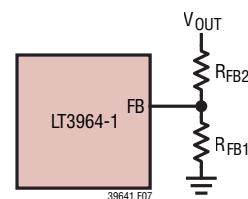


Figure 7. FB Resistor Configuration for Applications with Output Capacitor

If the OPENLED clamp voltage is programmed correctly using the resistor divider, then the FB pin should never exceed 1.08V to guarantee that the LED current is only regulated by the CTRL pin when the LEDs are connected. For best performance, set the OPENLED clamp voltage about 10% higher than the maximum LED string voltage.

If the output voltage is near the maximum when the LED string breaks, it may take too long for the feedback loop to adjust the inductor current and avoid overcharging the output. Thus, it is possible that the FB voltage can exceed the 1.18V regulation voltage momentarily. However, if the FB voltage exceeds 1.233V (typical), the overvoltage lockout threshold, the LT3964-1 will immediately stop switching and the PWMGTG driver is turned off. Meanwhile, the STATUS[0] bit (for Channel 1) or STATUS[4] bit (for Channel 2) in the chip status register is written to logic high, and the ALERT pin is also asserted.

For applications with wide dynamic and time-varying LED loads, a 100nF capacitance is recommended at the output node. However, if the output node can still overshoot beyond V_{IN} during an open circuit (OPENLED), then a Schottky diode is required to clamp output to V_{IN} , as shown in Figure 8. The BV rating of the Schottky has to be higher than the maximum V_{IN} . Another Schottky diode is

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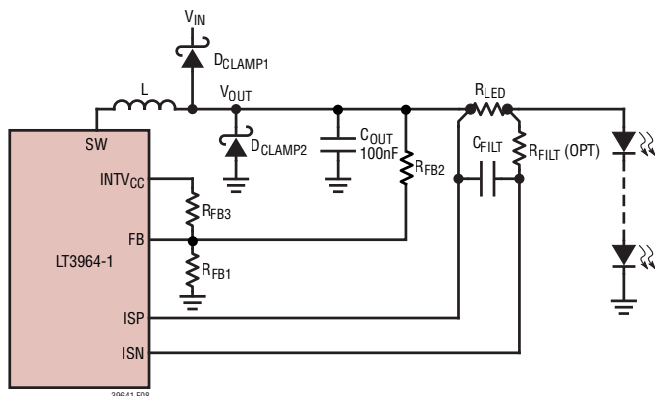


Figure 8. Output Clamp for Applications with No Output Capacitor

recommended to protect ISP and ISN from ringing below ground due to the excessive inductance in the LED string. To avoid falsely triggering the SHORTLED ($F_B < 250\text{mV}$), a resistor from INTV_{CC} to F_B is included to disable this feature.

OPENLED DETECTION

To detect open-circuit condition at the output, the LT3964-1 monitors both output voltage and current. When F_B exceeds $V_{FB} - 53\text{mV}$ and $V_{(ISP-ISN)}$ is less than 10mV , the OPENLED status bit, STATUS[1] for (Channel 1) or STATUS[5] for (Channel 2) in the chip status register, is written to logic 1, and the ALERT pin is also asserted.

SHORTLED AND OVERCURRENT PROTECTION FEATURE

The resistor network formed by R_{FB1} and R_{FB2} also defines the criteria for short-circuit (SHORTLED). For the LT3964-1, a short-circuit is when F_B is less than 250mV after initial start-up. STATUS[2] (for Channel 1) or STATUS[6] (for Channel 2) in the chip status register is set at the same time.

An application without direct output sensing is shown in Figure 6. LT3964-1 also monitors output overcurrent ($V_{(ISP-ISN)} > 930\text{mV}$ typically) to decide output short. Once an overcurrent is detected, the STATUS[3] bit (for Channel 1) or STATUS[7] bit (for Channel 2) in the chip status register is set, and the ALERT pin will be pulled low simultaneously.

In both cases, LT3964-1 stops switching and pulls PWM_{TG} high intermediately to disconnect the LED array from the power path as shown in Figure 9.

LT3964-1 has two different ways to respond to SHORTLED or OC fault: hiccup or latchoff. The default is the hiccup. Once a fault is detected, an internal fault timer starts. When the timer expires and the fault disappears, the LT3964-1 will re-startup. The PWM_{TG} is pulled high, and switching starts after a fixed internal soft start time. Figure 10 and Figure 11 show the LT3964-1 response to a short-circuit fault in hiccup mode. In I²C mode, the ALERT pin is kept asserted even though the fault is removed, whereas the ALERT pin is de-asserted in non-I²C mode.

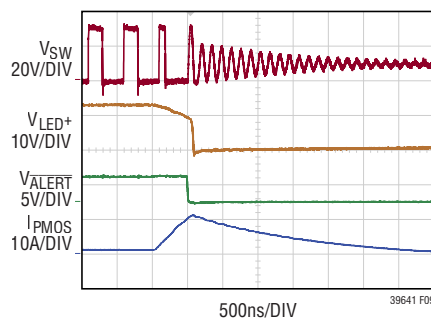


Figure 9. PWM TG Response to Short-Circuit Fault

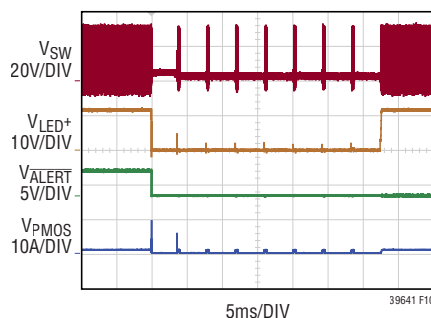


Figure 10. Hiccup Response to Short-Circuit Fault in I²C Mode

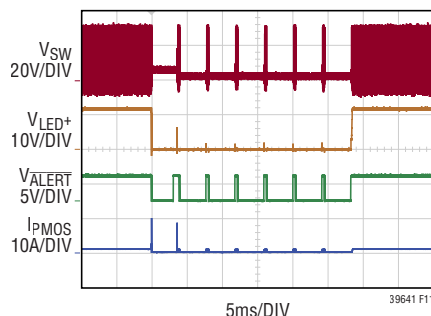


Figure 11. Hiccup Response to Short-Circuit Fault in Non-I²C Mode

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Latch-off mode is another way the LT3964-1 can be programmed to respond to faults. When a fault happens, the CONFIG[7] in the chip configuration register (see Table 11) is set via I²C, and LT3964-1 will stop switching and pull the PWM_{LG} pin high immediately. LT3964-1 will stay non-switching even if all faults have been removed as shown in Figure 12. To exit latchoff mode, the EN/UVLO pin must be toggled low to high.

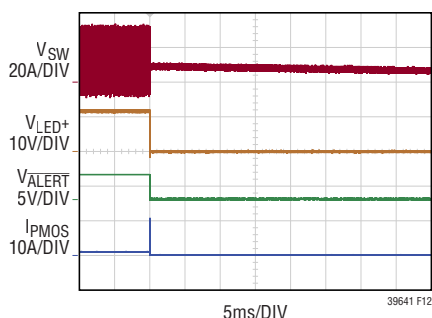


Figure 12. Latch-off Response to a Short-Circuit Fault

PRECAUTIONS REGARDING REVERSED INPUT CURRENT

LT3964-1 is not designed to run a large reversed input current, greater than 200mA continuously, from the SW pin to the V_{IN} pin through the top switch when the top switch is in the off state. This cautionary note explains the situation where this potentially damaging condition can develop, and what measures can be taken to protect the top switch if this condition is likely. Small negative inductor currents, 100mA or less, are expected and acceptable for periods less than a switching cycle. This is expected during normal operation at low LED current. One event that causes large, potentially damaging negative inductor currents to flow through the parasitic body diode of the top switch is a ground fault on the supply when the output is charged. This input fault event is not common, but the user should be aware of it. The three conditions which, when seen together, are more likely to lead to a potentially damaging reverse current level while the top switch is off are:

1. The buck output voltage is almost equal to V_{IN} supply,
2. The output voltage is high at the beginning of the switching cycle, and

3. The inductor current is close to zero when the low side turns on briefly to charge the BST capacitor.

The reason these three conditions can lead to sustained negative inductor current is that when the bottom switch is ON, big voltage is seen across the inductor to cause a large negative inductor ripple even for a 40ns period of time (bottom switch minimum ON time). After the bottom switch turns off, both switches are in an off state for the remaining switch cycle. Thus, the negative inductor current continues to flow backwards through the top switch body diode for an extended period of time due to little voltage across the inductor. The V_{IN} equal to V_{OUT} condition can be encountered during an OPENLED event if the constant voltage regulation is set close to V_{IN}, and alternatively, if V_{IN} drops to a level where the LED V_f is close to V_{IN}. In the former instance (OPENLED), the switching will be discontinuous since there is no load, so the inductor current is likely going negative during the BST refresh cycle when the low switch is on. If this operational condition is expected (i.e., V_{OUT}/(V_{OUT} - V_{IN}) > 10), a 10μH or larger value inductor will prevent generating a large negative inductor current during a brief pulse on the synchronous FET. For applications that are running at high die temperature over 125°C, a Schottky diode is strongly suggested to provide extra protection and bypass the negative inductor current around the top switch, as shown in Figure 13.

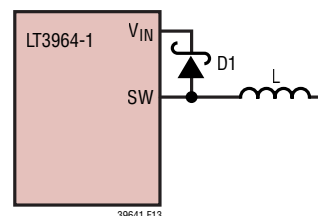


Figure 13. Reverse Input Current Protection

CHANNEL-LEVEL ALERT REPORTING

When a channel-level fault happens, the LT3964-1 will set the corresponding reporting bit in the chip status register (see Table 7), which is also latched until the main device sends a command to reset it. If the corresponding bit in the chip status register (see Table 8) is high, LT3964-1 will report this fault by pulling down the ALERT pin.

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Table 7. Chip Status Register

CHIP STATUS REGISTER[BIT]	VALUE	SETTING
STATUS[0]	0* 1	Ch1 Output Voltage Normal Ch1 Output Overvoltage (OVFB)
STATUS[1]	0* 1	Ch1 LED Normal Ch1 LED Open (OPENLED)
STATUS[2]	0* 1	Ch1 LED Normal Ch1 LED Shorted (SHORTLED)
STATUS[3]	0* 1	Ch1 Output Current Normal Ch1 Output Overcurrent (OC)
STATUS[4]	0* 1	Ch2 Output Voltage Normal Ch2 Output Overvoltage (OVFB)
STATUS[5]	0* 1	Ch2 LED Normal Ch2 LED Open (OPENLED)
STATUS[6]	0* 1	Ch2 LED Normal Ch2 LED Shorted (SHORTLED)
STATUS[7]	0* 1	Ch2 Output Current Normal Ch2 Output Overcurrent (OC)

*Denotes Default Power-On Value.

Table 8. Chip Status Enable Register

CHIP STATUS ENABLE REGISTER[BIT]	VALUE	SETTING
STATEN[0]	0 1*	Disable Reporting Ch1 OVFB Enable Reporting Ch1 OVFB
STATEN [1]	0 1*	Disable Reporting Ch1 OPENLED Enable Reporting Ch1 OPENLED
STATEN [2]	0 1*	Disable Reporting Ch1 SHORTLED Enable Reporting Ch1 SHORTLED
STATEN [3]	0 1*	Disable Reporting Ch1 OC Enable Reporting Ch1 OC
STATEN [4]	0 1*	Disable Reporting Ch2 OVFB Enable Reporting Ch2 OVFB
STATEN [5]	0 1*	Disable Reporting Ch2 OPENLED Enable Reporting Ch2 OPENLED
STATEN [6]	0 1*	Disable Reporting Ch2 SHORTLED Enable Reporting Ch2 SHORTLED
STATEN [7]	0 1*	Disable Reporting Ch2 OC Enable Reporting Ch2 OC

*Denotes Default Power-On Value.

The LT3964-1 will respond to the main device alert response inquiry (ARI) by returning the chip address. If operated in I²C mode, the $\overline{\text{ALERT}}$ pin is kept asserted until the transfer is successfully completed. After that, the LT3964-1 will not respond to future ARI requests until a new alert event occurs and the $\overline{\text{ALERT}}$ pin is asserted again. Once the main device receives the chip address,

the main device will decide whether to read back the full alert information from LT3964-1 and reset the chip status register. To minimizing the alert reporting, LT3964-1 doesn't report the same fault over again if the corresponding STATUS bit is not cleared.

In non-I²C mode, the LT3964-1 reports faults independent of the I²C register. Whenever LT3964-1 detects OVFB and OPENLED faults, the $\overline{\text{ALERT}}$ pin is asserted. SHORTLED and OC faults usually keep the $\overline{\text{ALERT}}$ pin asserted until the internal soft-start fault timer expires and the faults have been removed.

PWM DIMMING CONTROL FOR BRIGHTNESS

PWM dimming is used to modulate the LED current between zero and full current to achieve a precisely programmed average current, without the possibility of color shift that occurs at low current in LEDs. To make PWM dimming more accurate, the switch demand current is stored on the internal VC node during the quiescent phase when PWM is low. This feature minimizes recovery time when the PWM signal goes high. To further improve the recovery time, a disconnect switch should be used in the LED current path to prevent the output capacitor from discharging during the PWM signal low phase. The minimum PWM on or off time depends on the choice of operating frequency set by the RT input. For best current accuracy, the minimum PWM high time should be at least two switching cycles ($1\mu\text{s}$ for $f_{\text{SW}} = 2\text{MHz}$).

A low-duty cycle PWM signal can cause excessive start-up times if it is allowed to interrupt the soft-start sequence. Therefore, once start-up is initiated, the LT3964-1 will ignore a logical disable by the PWM input signal. The device will continue to soft-start with switching and TG enabled until either the internal soft-start time expires or the output current reaches one-fifth of the full-scale current. At this point, the device will begin following the dimming control as designated by the PWM pin input or PWM input via I²C.

The internal PWM dimming signal is controlled by both PWM pin input (PWMEXT) and I²C PWM registers (CH1PWM1, CH1PWM2, CH2PWM1, CH2PWM2). It can be updated according to the intended dimming frequency

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and dimming duty cycle. The PWM registers for Channel 1 shown in Tables 9 and 10 have outputs given by Equation 8.

$$\text{PWM Frequency} = \frac{f_{\text{SW}}}{2^{\text{SCALE}[2:0]+6}}$$

$$\text{PWM Duty Cycle} = \frac{\text{CH1_ON}[12:7] - \text{SCALE}[2:0]}{2^{\text{SCALE}[2:0]+6}} \quad (8)$$

where f_{SW} is the switching frequency. For example, if $\text{SCALE}[2:0] = 7$, then the PWM frequency is $f_{\text{SW}}/8192$, and the PWM duty cycle is $\text{CH1_ON}[12:0]/8192$. If $\text{SCALE}[2:0] = 0$, then PWM frequency is $f_{\text{SW}}/64$. The lower order bits, $\text{CH1_ON}[6:0]$, are neglected and the PWM duty cycle is defined by $\text{CH1_ON}[12:7]/64$.

Note the maximum achievable PWM duty cycle set by PWM registers is 8191/8192. To achieve 100% PWM dimming, the $\text{CONFIG}[3]/[2]$ in the chip configuration register has to be cleared. Usually, PWM registers offer better PWM dimming performance as the dimming control signals are aligned with the internal clock.

The $\text{CONFIG}[0] = 1$ also initializes CH2's PWM dimming counter with one half dimming cycle shift, which can avoid simultaneous channel switching at the beginning of dimming cycles to reduce switching transients (see Figure 14 and Figure 15).

Table 9. Channel 1 (CH1) PWM Register 1 (CH1PWM1)

CH1 PWM REGISTER1[BIT]	VALUE	SETTING
CH1PWM1[0]	0* 1	PWMON Time LSB CH1_ON[0] = 0 PWMON Time LSB CH1_ON [0] = 1
CH1PWM1[1]	0* 1	PWMON Time 12th MSB CH1_ON [1] = 0 PWMON Time 12th MSB CH1_ON [1] = 1
CH1PWM1[2]	0* 1	PWMON Time 11th MSB CH1_ON[2] = 0 PWMON Time 11th MSB CH1_ON [2] = 1
CH1PWM1[3]	0* 1	PWMON Time 10th MSB CH1_ON[3] = 0 PWMON Time 10th MSB CH1_ON [3] = 1
CH1PWM1[4]	0* 1	PWMON Time 9th MSB CH1_ON[4] = 0 PWMON Time 9th MSB CH1_ON[4] = 1
CH1PWM1[5]	0* 1	PWMON FREQ Scalar LSB SCALE[0] = 0 PWMON FREQ Scalar LSB SCALE[0] = 1
CH1PWM1[6]	0* 1	PWMON FREQ Scalar 2nd MSB SCALE[1] = 0 PWMON FREQ Scalar 2nd MSB SCALE[1] = 1
CH1PWM1[7]	0* 1	PWMON FREQ Scalar MSB SCALE[2] = 0 PWMON FREQ Scalar MSB SCALE[2] = 1

*Denotes Default Power-On Value for I²C Mode. PWMON Denotes PWM-ON TIME. FREQ Denotes PWM Frequency.

Table 10. Channel 1 (CH1) PWM Register 2 (CH1PWM2)

CH1 PWM REGISTER2 [BIT]	VALUE	SETTING
CH1PWM2[0]	0* 1	PWMON Time 8th MSB CH1_ON[5] = 0 PWMON Time 8th MSB CH1_ON[5] = 1
CH1PWM2[1]	0* 1	PWMON Time 7th MSB CH1_ON[6] = 0 PWMON Time 7th MSB CH1_ON[6] = 1
CH1PWM2[2]	0* 1	PWMON Time 6th MSB CH1_ON[7] = 0 PWMON Time 6th MSB CH1_ON[7] = 1
CH1PWM2[3]	0* 1	PWMON Time 5th MSB CH1_ON[8] = 0 PWMON Time 5th MSB CH1_ON[8] = 1
CH1PWM2[4]	0* 1	PWMON Time 4th MSB CH1_ON[9] = 0 PWMON Time 4th MSB CH1_ON[9] = 1
CH1PWM2[5]	0* 1	PWMON Time 3rd MSB CH1_ON[10] = 0 PWMON Time 3rd MSB CH1_ON[10] = 1
CH1PWM2[6]	0* 1	PWMON Time 2nd MSB CH1_ON[11] = 0 PWMON Time 2nd MSB CH1_ON[11] = 1
CH1PWM2[7]	0* 1	PWMON Time 1st MSB CH1_ON[12] = 0 PWMON Time 1st MSB CH1_ON[12] = 1

*Denotes Default Power-On Value for I²C Mode.

Table 11. Chip Configuration Register

CHIP CONFIGURATION REGISTER [BIT]	VALUE	SETTING
CONFIG[0]	0* 1	IN phase PWM dimming OUT phase PWM dimming
CONFIG[1]	x	Not Used
CONFIG[2]	0 1*	Channel 2 PWM Registers' Output Disabled (Always On) Channel 2 PWM Registers' Output Enabled
CONFIG[3]	0 1*	Channel 1 PWM Registers' Output Disabled (Always On). Channel 1 PWM Registers' Output Enabled
CONFIG[4]	x	Not Used
CONFIG[5]	x	No Used
CONFIG[6]	0* 1	Clock Output Disabled Clock Output Enabled
CONFIG[7]	0* 1	Latchoff Mode Disabled Latchoff Mode Enabled

*Denotes Default Power-On Value for I²C Mode.
CONFIG[2] = 0, CONFIG[3] = 0 for Non-I²C Mode After Power On

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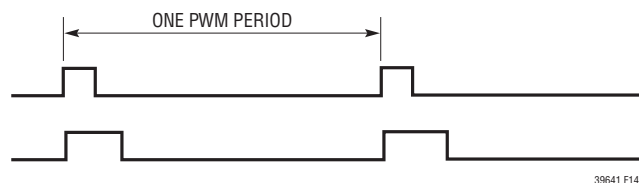


Figure 14. CH1 and CH2 PWM Dimming are IN Phase (CONFIG[0] = 0)

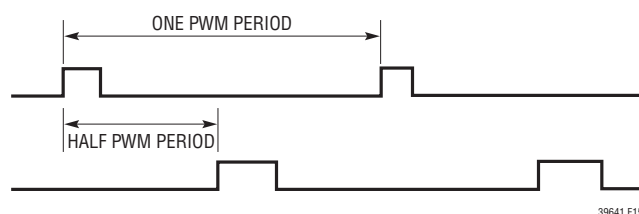


Figure 15. CH1 and CH2 PWM Dimming are 180-Degree Out-of-Phase (CONFIG[0] = 1)

I²C OPERATION

I²C Interface

The LT3964-1 communicates with a bus main device using the standard I²C 2-wire interface. The two bus lines, SDA and SCL, must be HIGH when the bus is not in use. External pull-up resistors or current sources are required on these lines. The LT3964-1 is both a subordinate receiver and a subordinate transmitter. The I²C control signals, SDA and SCL have TTL thresholds (min 1.5V high threshold and max 0.4V low threshold). I²C internal logic gates are powered from INTV_{CC}. When INTV_{CC} is below approximately 3.2V, the I²C serial port is reset to power-on states and registers are set to default values.

I²C Bus Speed

The I²C port operates at speeds up to 400kHz. It has built-in timing delays to ensure correct operation when addressed from an I²C-compliant main device. It also contains input filters designed to suppress glitches should the bus become corrupted.

I²C START and STOP Conditions

Figure 16 shows I²C port timing information. A bus main signals the beginning of communications by transmitting

a START condition. A START condition is generated by transitioning SDA from HIGH to LOW while SCL is HIGH. The main device may transmit either the subordinate write or the subordinate read address. Once data is written to the LT3964-1, the main device may transmit a STOP condition that commands the LT3964-1 to act upon its new command set. A STOP condition is sent by the main device by transitioning SDA from LOW to HIGH while SCL is HIGH. The bus is then free for communication with another I²C device.

I²C Byte Format

Each byte sent to or received from the LT3964-1 must be 8 bits long, followed by an extra clock cycle for the acknowledge bit. The data should be sent to the LT3964-1 most significant bit (MSB) first.

I²C Acknowledge

The acknowledge signal is used for handshaking between the main and the subordinate devices. When the LT3964-1 is written to, it acknowledges its write address and subsequent register address and data bytes. When reading from the LT3964-1, it acknowledges its read address and 8-bit status byte. An acknowledge pulse (active LOW) generated by the LT3964-1 lets the main device know that the latest byte of information was transferred. The main device generates the clock cycle and releases the SDA line (HIGH) during the acknowledge clock cycle. The LT3964-1 pulls down the SDA line during the write acknowledge clock pulse so that it is a stable LOW during the HIGH period of this clock pulse.

I²C Device Addressing

Eight distinct bus addresses are configurable using ADDR2 and ADDR1 pins. Table 12 shows the correspondence between ADDR2 and ADDR1 pin states and addresses. The least significant bit of the address byte, known as the read/write bit, is 0 when writing data to the LT3964-1 and 1 when reading from it. There is also one global address available at 0001100R/W to send or inquire information from all subordinate devices on the same I²C bus (see I²C broadcast mode for more information).

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**Table 12. Subordinate Device Address Map
(110 A3 A2 A1 A0 R/W)**

ADDR2	ADDR1	A3	A2	A1	A0
GND	FLOAT	0	0	0	1
GND	INTV _{CC}	0	0	1	1
FLOAT	GND	0	1	0	0
FLOAT	FLOAT	0	1	0	1
FLOAT	INTV _{CC}	0	1	1	1
INTV _{CC}	GND	1	1	0	0
INTV _{CC}	FLOAT	1	1	0	1
INTV _{CC}	INTV _{CC}	1	1	1	1
GND*	GND	0	0	0	0

I²C Sub-Addressed Writing

The LT3964-1 has nine command registers that can be accessed by the I²C port via a sub-addressed writing system. Each write cycle of the LT3964-1 consists of a series of three bytes beginning with the LT3964-1 write address. The second byte is the sub-address of the command register being written to. The sub-address is a pointer to the register where the data in the third byte will be stored. The third byte is the data to be written to the just-received sub-address.

I²C Bus Write Operation

The main device initiates communication with the LT3964-1 with a START condition, and the LT3964-1 write address. If the address matches that of the LT3964-1, the LT3964-1 returns an acknowledge pulse. The main device should then deliver the sub-address. Again, the LT3964-1 acknowledges, and the cycle is repeated for the data byte. The data byte is transferred to an internal holding latch upon the return of its acknowledgement by the LT3964-1. If desired a REPEAT-START condition may be initiated by the main device where another device on the I²C bus is addressed. The LT3964-1 remembers the valid data it has received. Once all the devices on the I²C have been addressed and sent valid data and a global STOP has been sent, the LT3964-1 will update its command latches with the data it has received. Figure 17 shows the LT3964-1 I²C serial port write pattern.

I²C Sub-Addressed Reading

The LT3964-1 I²C interface supports random address reading of the I²C command and status registers. Before reading a register, the register's sub-address must be written. Send a START condition followed by the LT3964-1 write address followed by the sub-address of the register to be read. The sub-address is now stored as a pointer to the register. Send a REPEAT-START condition followed by the LT3964-1 read address. Following the acknowledgement of its read address the LT3964-1 returns one bit of information for each of the next 8-clock cycles. A STOP condition is not required for the read operation. The read sub-address is stored until a new sub-address is written. Verify the data written to the internal data hold latches prior to committing data to the command registers by reading back the data before sending a STOP condition. Continuously poll a register by repeatedly sending a START condition followed by the LT3964-1 read address, and then clocking the data out after the read address is acknowledged. Figure 17 shows the LT3964-1 I²C serial port read pattern.

I²C Command and Status Registers

There are nine I²C command/status registers and three read-only I²C part number registers in the LT3964-1. All of the information for these registers is shown in Table 13.

I²C Broadcast (BCMODE)

The BCMODE write command (0001 1000) is used to synchronize the PWM dimming cycles among the multiple LT3964-1 subordinates on the I²C bus. The LT3964-1 subordinates must be operating with a common external clock in order to be synchronized. The command does not modify any register bits. It only resets each channel counter to synchronize the dimming cycles.

The BCMODE read command (0001 1001) is used to inquire about which LT3964-1 subordinate on the bus is sending the alert (see Alert Response Protocol section for details). This command is two bytes long. The first byte is the broadcast read address 00011001. The second byte 110A₃A₂A₁A₀0 is sent by the alerting subordinate device, where A₃A₂A₁A₀ is an input logic value from the programmable address select pins ADDR2 and ADDR1 shown in Table 12. Figure 19 shows the LT3964-1 BCMODE read pattern.

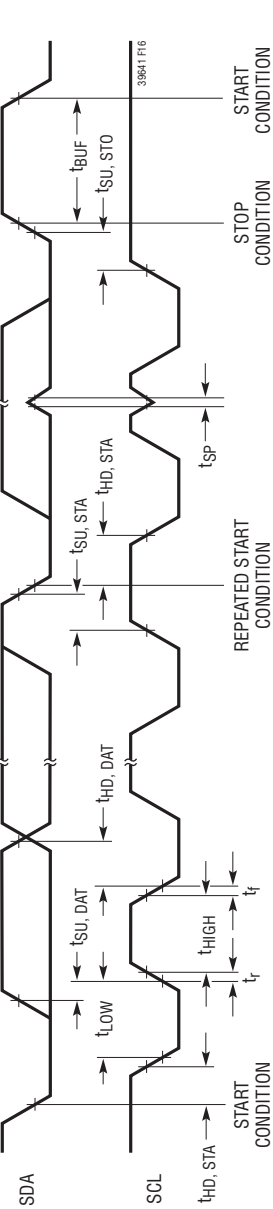


Figure 16. I²C Serial Port Timing

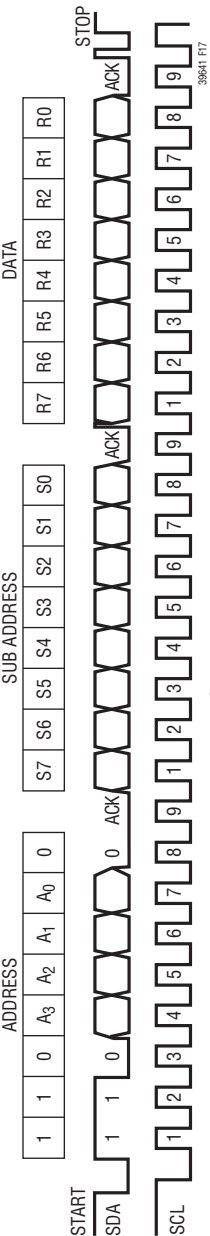


Figure 17. LT3964-1 I²C Serial Port Multiple Write Pattern

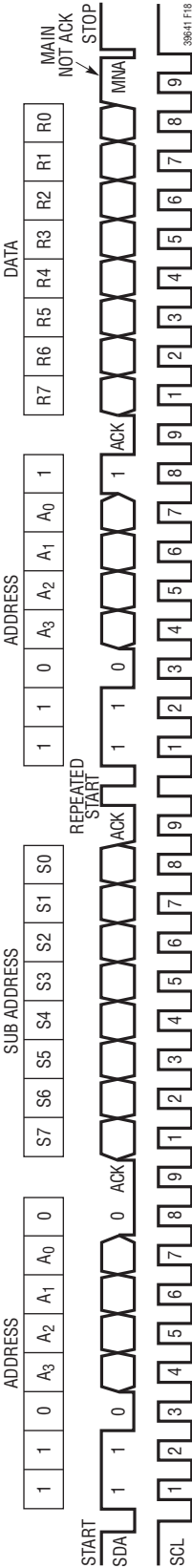


Figure 18. LT3964-1 I²C Serial Port Read Pattern

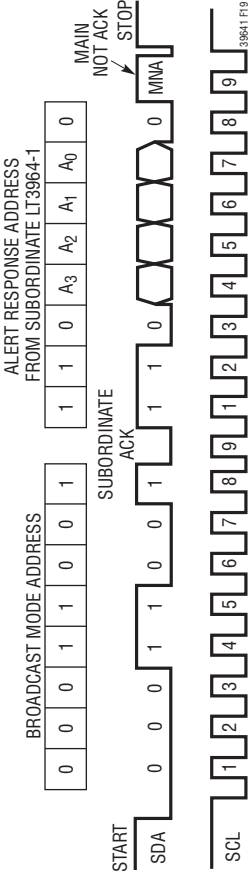


Figure 19. LT3964-1 I²C Serial Port Broadcast Read Pattern

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Table 13. LT3964-1 Command Register Table

REG	NAME	B[7]	B[6]	B[5]	B[4]	B[3]	B[2]	B[1]	B[0]	DEFAULT
0x01	CONFIG	Latchoff Mode Enable Bit 0 = Disabled 1 = Enabled	Clock Output Enable Bit 0 = Disabled 1 = Enabled	Not Used	Not Used	Channel 1 Pulse Dim Enable Bit 0 = Disabled (Always On) 1 = Enabled	Channel 2 Pulse Dim Enable Bit 0 = Disabled (Always On) 1 = Enabled	Not Used	PWM Dimming Phase Shift Bit 0 = Ch1 and Ch2 PWM Dimming in Phase 1 = Ch1 and Ch2 PWM Dimming 180-Degree Phase Shift	00xx 1100 (I ² C Mode) 00xx0000 (non-I ² C Mode)
0x02	CH1PWM1	Channel 1 PWM FREQ Scale MSB	Channel 1 PWM FREQ Scale 2nd MSB	Channel 1 PWM FREQ Scale LSB	Channel 1 PWM ON Time 9th MSB	Channel 1 PWM ON Time 10th MSB	Channel 1 PWM ON Time 11th MSB	Channel 1 PWM ON Time 12th MSB	Channel 1 PWM ON Time LSB	0000 0000
0x03	CH1PWM2	Channel 1 PWM ON Time MSB	Channel 1 PWM ON Time 2nd MSB	Channel 1 PWM ON Time 3rd MSB	Channel 1 PWM ON Time 4th MSB	Channel 1 PWM ON Time 5th MSB	Channel 1 PWM ON Time 6th MSB	Channel 1 PWM ON Time 7th MSB	Channel 1 PWM ON Time 8th MSB	0000 0000
0x04	CH2PWM1	Channel 2 PWM FREQ Scale MSB	Channel 2 PWM FREQ Scale 2nd MSB	Channel 2 PWM FREQ Scale LSB	Channel 2 PWM ON Time 9th MSB	Channel 2 PWM ON Time 10th MSB	Channel 2 PWM ON Time 11th MSB	Channel 2 PWM ON Time 12th MSB	Channel 2 PWM ON Time LSB	0000 0000
0x05	CH2PWM2	Channel 2 PWM ON Time MSB	Channel 2 PWM ON Time 2nd MSB	Channel 2 PWM ON Time 3rd MSB	Channel 2 PWM ON Time 4th MSB	Channel 2 PWM ON Time 5th MSB	Channel 2 PWM ON Time 6th MSB	Channel 2 PWM ON Time 7th MSB	Channel 2 PWM ON Time 8th MSB	0000 0000
0x06	ADIM1	Channel 1 Analog Dimming MSB	Channel 1 Analog Dimming 2nd MSB	Channel 1 Analog Dimming 3rd MSB	Channel 1 Analog Dimming 4th MSB	Channel 1 Analog Dimming 5th MSB	Channel 1 Analog Dimming 6th MSB	Channel 1 Analog Dimming 7th MSB	Channel 1 Analog Dimming LSB	1111 1111
0x07	ADIM2	Channel 2 Analog Dimming MSB	Channel 2 Analog Dimming 2nd MSB	Channel 2 Analog Dimming 3rd MSB	Channel 2 Analog Dimming 4th MSB	Channel 2 Analog Dimming 5th MSB	Channel 2 Analog Dimming 6th MSB	Channel 2 Analog Dimming 7th MSB	Channel 2 Analog Dimming LSB	1111 1111
0x08	STATEN	Channel 2 Overcurrent Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 2 SHORTLED Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 2 OPENLED Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 2 Overvoltage Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 1 Overcurrent Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 1 SHORTLED Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 1 OPENLED Reporting Enable Bit 0 = Disabled 1 = Enabled	Channel 1 Overvoltage Reporting Enable Bit 0 = Disabled 1 = Enabled	1111 1111
0x09	STATUS	Channel 2 Overcurrent Reporting Bit 0 = NO 1 = YES	Channel 2 SHORTLED Reporting Bit 0 = NO 1 = YES	Channel 2 OPENLED Reporting Bit 0 = NO 1 = YES	Channel 2 Overvoltage Reporting Bit 0 = NO 1 = YES	Channel 1 Overcurrent Reporting Bit 0 = NO 1 = YES	Channel 1 SHORTLED Reporting Bit 0 = NO 1 = YES	Channel 1 OPENLED Reporting Bit 0 = NO 1 = YES	Channel 1 Overvoltage Reporting Bit 0 = NO 1 = YES	0000 0000

APPLICATIONS INFORMATION

ALERT RESPONSE PROTOCOL

In a system where several subordinate devices share a common interrupt line, the main device can use the alert response address (ARA) to determine which device initiated the interrupt. The main device initiates the ARA procedure with a START condition and the special 7-bit ARA bus address (0001100) followed by the read bit (R) = 1. If the LT3964-1 is asserting the $\overline{\text{ALERT}}$ pin, it acknowledges and responds by sending its 7-bit bus address (110A₃A₂A₁A₀) and a 0. While it is sending its address, it monitors the SDA pin to see if another device is sending an address at the same time using standard I²C bus arbitration. If the LT3964-1 is sending a 1 and reads a 0 on the SDA pin on the rising edge of SCL, it assumes another device with a lower address is sending and the LT3964-1 immediately aborts its transfer and waits for the next ARA cycle to try again. If the transfer is successfully completed, the LT3964-1 will de-assert its $\overline{\text{ALERT}}$ pin and will not respond to further ARA requests until a new alert event occurs.

DESIGNING THE PRINTED CIRCUIT BOARD

For proper operation and minimum EMI, care must be taken during printed circuit board layout. Usually, large switched currents flow through the local input capacitors and the V_{IN} and GND pins. The loops travelled by these currents should be made as small as possible by keeping the capacitors as close as possible to these pins. These capacitors, as well as the large inductor, should be placed on the same side of the board as the LT3964-1 and connected on the same layer. Other large, bulk input capacitors can be safely placed farther from the chip and on the other side of the board.

Create a Kelvin ground network by keeping the ground connection for all of the other components separate. It should only join the ground for the input and output capacitors and the return path for the LED current at the exposed pad. To keep thermal resistance low, extend the ground plane as much as possible, and thermal vias under and near the LT3964-1 to additional ground planes within the circuit board and on the bottom side.

There are a few other aspects of the board design that improve performance. Likewise minimizing the area of the SW and BST nodes reduces noise. The traces for FB pins should be kept short to lessen the susceptibility of these high-impedance nodes to noise. Minimizing the connections from the external current sense resistor R_{LED} to the ISP and ISN pins are essential for current regulation accuracy. The INTV_{CC} bypass capacitor as well as the BST capacitor, should be placed as closely as possible to their respective pins.

Figure 20 shows the simplified two-sided layout of power component placement with traces, ground plane and via locations. Note that the 4-layer layout is recommended for best performance. Contact the factory for the reference layout design.

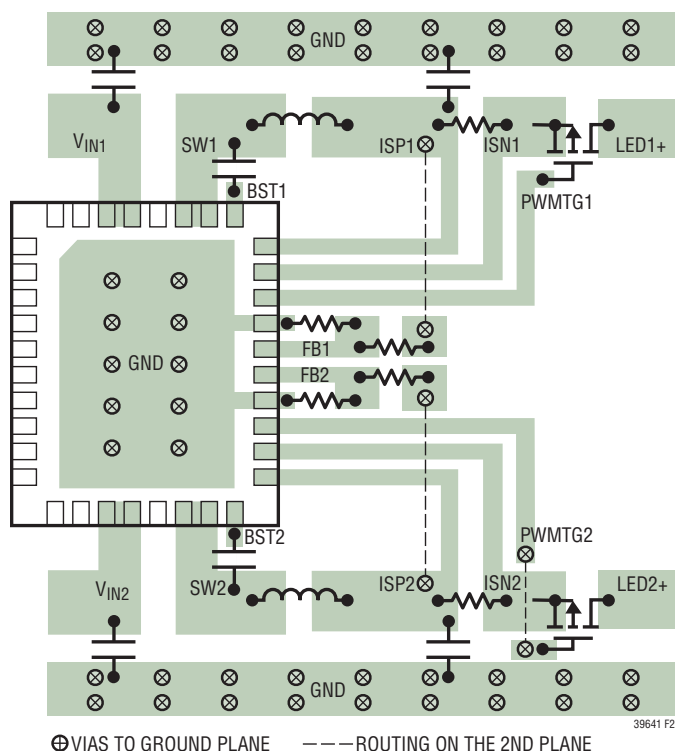
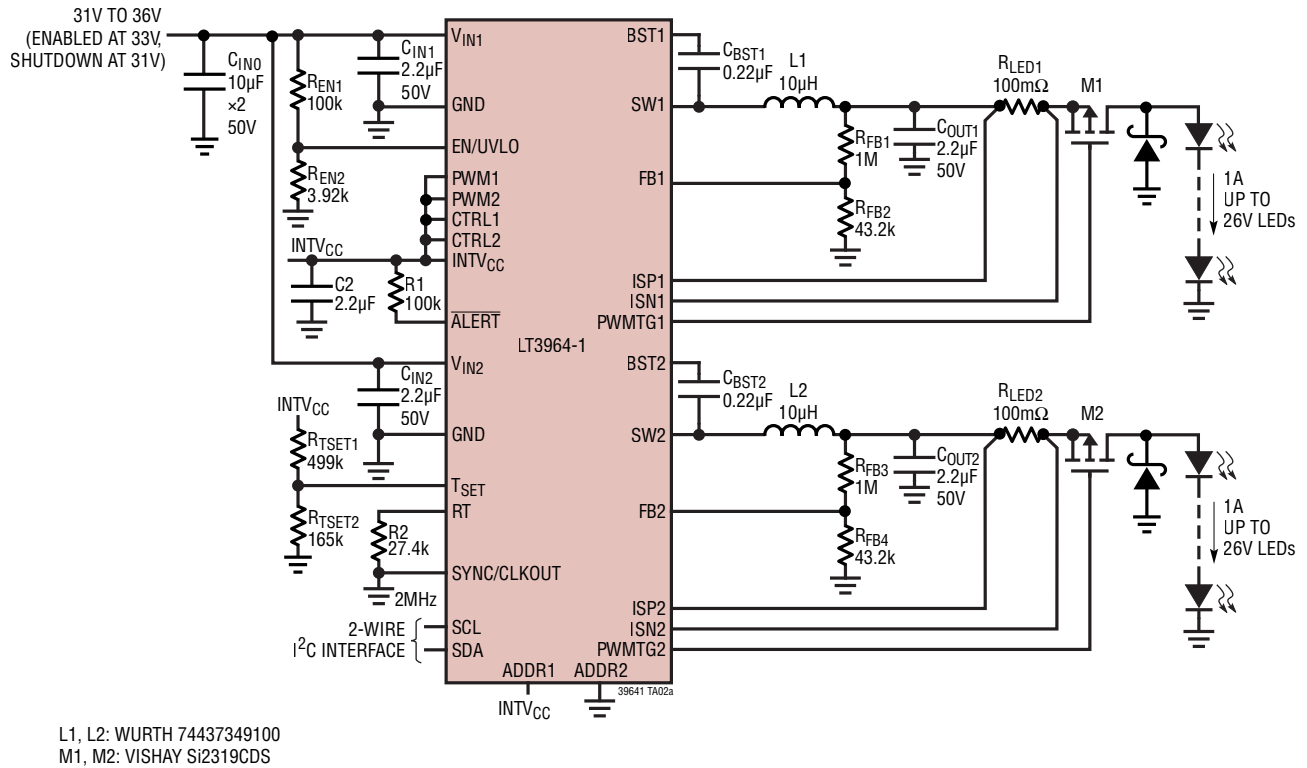


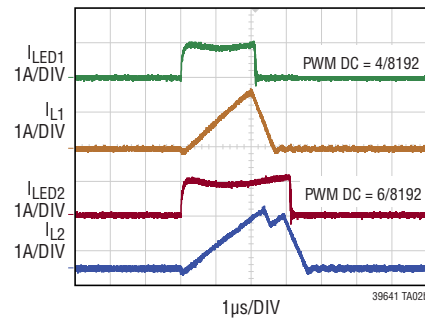
Figure 20. Simplified Layout for Dual Buck LED Driver

TYPICAL APPLICATION

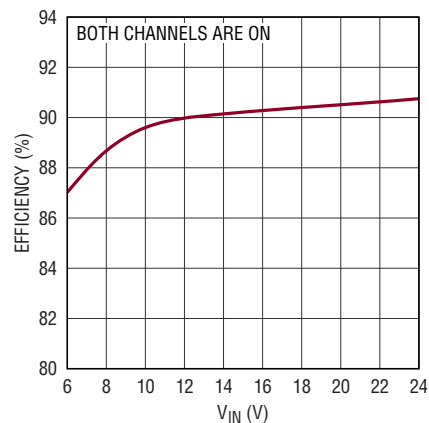
Short-LED Robust, 50W Dual Buck 1A LED Driver with Internal PWM Dimming



PWM Dimming at $V_{IN} = 34V$

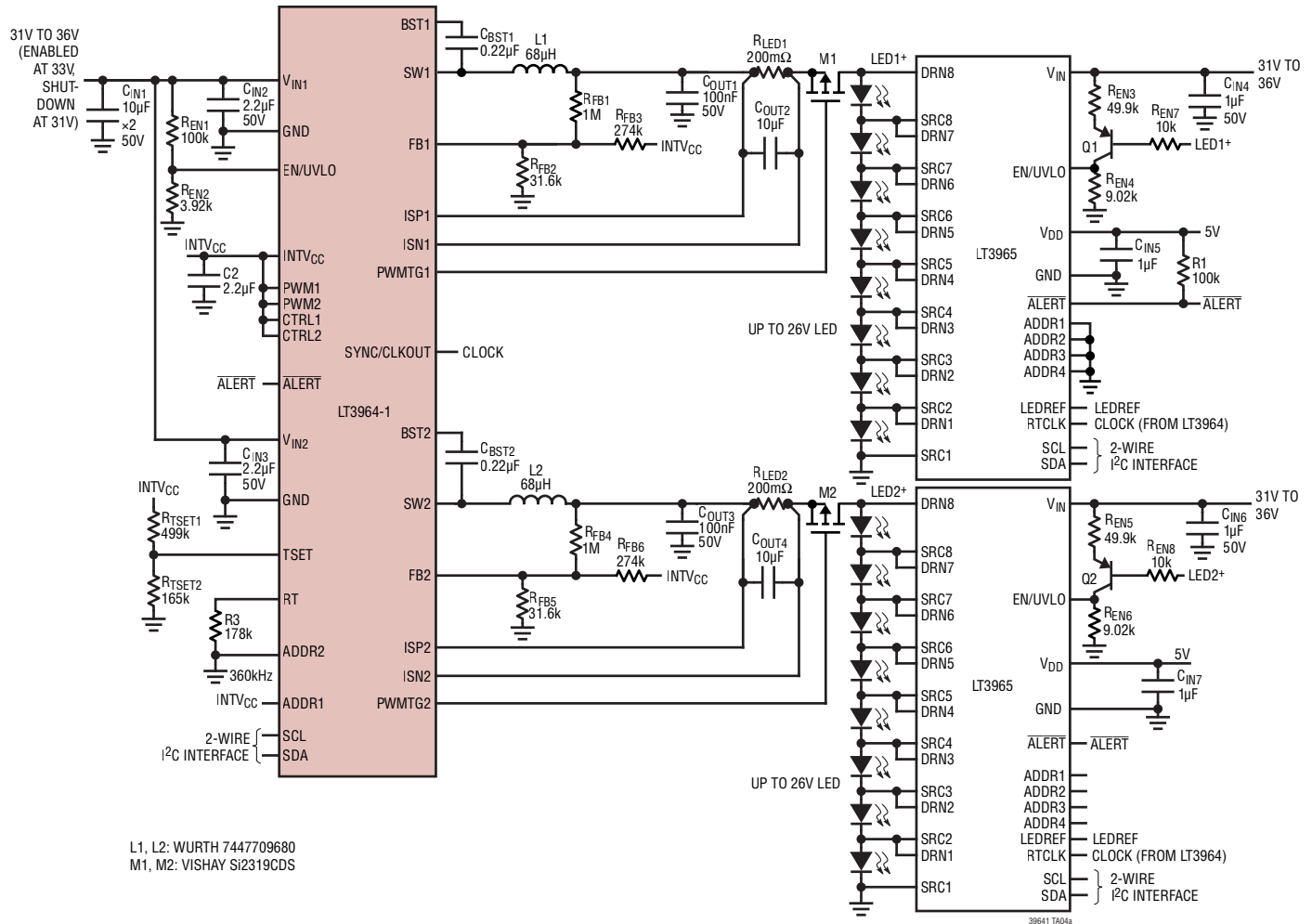


Efficiency

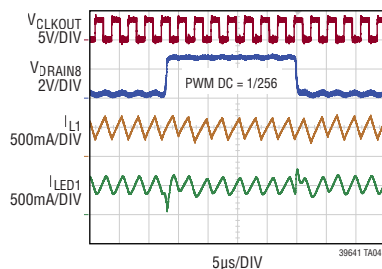


TYPICAL APPLICATION

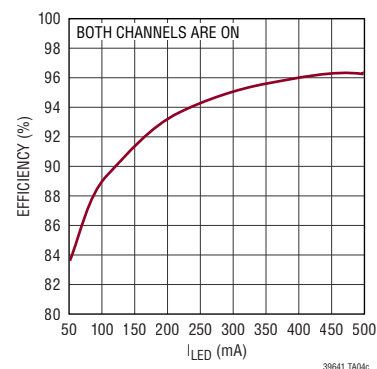
Matrix LED Driver



Single LED PWM Dimming at $V_{IN} = 34V$



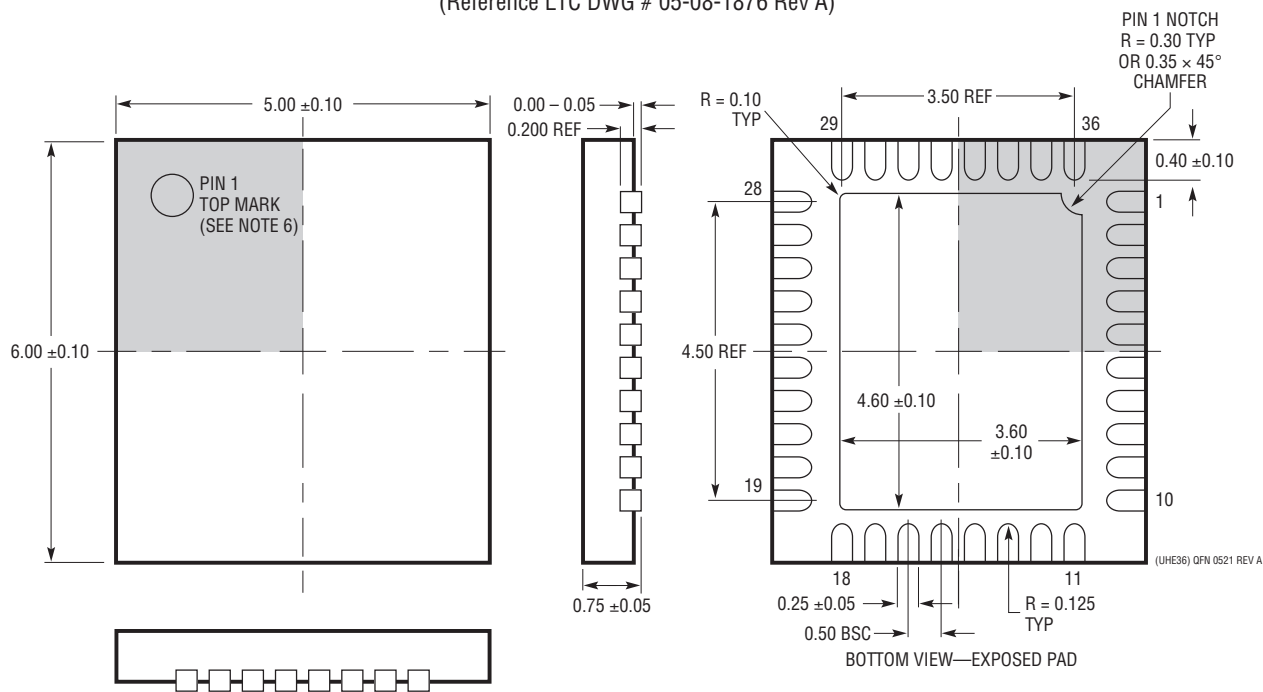
Efficiency, $V_{IN} = 34V$



PACKAGE DESCRIPTION



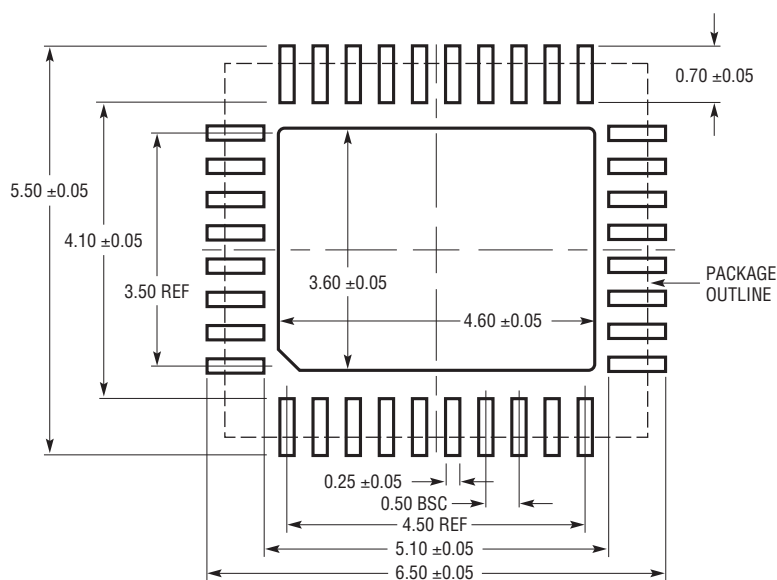
UHE Package
36-Lead Plastic QFN (5mm × 6mm)
 (Reference LTC DWG # 05-08-1876 Rev A)



NOTE:

1. DRAWING IS NOT A JEDEC PACKAGE OUTLINE
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS

4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.20mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

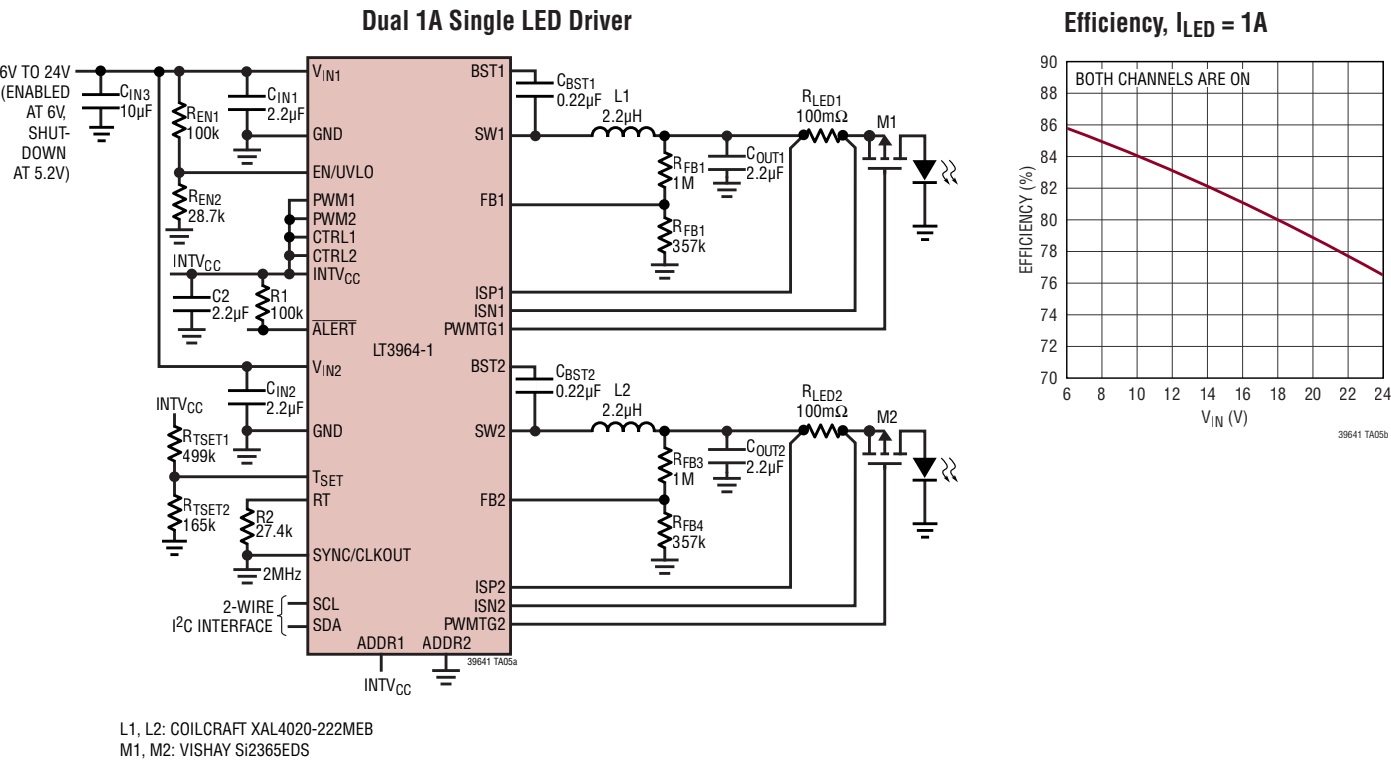


RECOMMENDED SOLDER PAD LAYOUT
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED

REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
0	9/23	Initial Release.	—

TYPICAL APPLICATION



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT3922	36V, 2A Synchronous Step-Up LED Driver	$V_{IN(MIN)} = 2.8V$, $V_{IN(MAX)} = 36V$, $V_{OUT} = 40V$, 128:1 Internal Dimming and 5,000:1 External Dimming, $I_{SD} = 1\mu A$, 4mm × 5mm QFN-28
LT3932	36V, 2A Synchronous Step-Down LED Driver	$V_{IN(MIN)} = 3.6V$, $V_{IN(MAX)} = 36V$, $V_{OUT} = 0V$ to 36V, 128:1 Internal Dimming and 5,000:1 External Dimming, $I_{SD} = 1\mu A$, 4mm × 5mm QFN-28
LT3952	60V, 4A Synchronous Step-Up LED Driver	$V_{IN(MIN)} = 3V$, $V_{IN(MAX)} = 42V$, $V_{OUT} = 0V$ to 60V, 5:1 Internal Dimming and 4,000:1 External Dimming, $I_{SD} = 1\mu A$, TSSOP-28E
LT3795	High Side 110V, 1MHz LED Driver with 3,000:1 PWM Dimming with Spread Spectrum Frequency Modulation	$V_{IN(MIN)} = 4.5V$, $V_{IN(MAX)} = 110V$, $V_{OUT} = 110V_{MAX}$, 3000:1 PWM, 20:1 Analog, $I_{SD} < 1\mu A$, TSSOP-28E
LT3956	80V _{IN} /80V _{OUT} , $I_{SW} = 3.3A$, 1MHz LED Driver with 3,000:1 PWM Dimming	$V_{IN(MIN)} = 4.5V$, $V_{IN(MAX)} = 80V$, $V_{OUT} = 40V_{MAX}$, 3000:1 PWM, 20:1 Analog, $I_{SD} < 1\mu A$, 5mm × 6mm QFN-36
LT3761	High Side 100V, 1MHz LED Controller with 3,000:1 PWM Dimming and Internal PWM Generator	$V_{IN(MIN)} = 4.5V$, $V_{IN(MAX)} = 60V$, $V_{OUT} = 80V_{MAX}$, 3000:1 PWM, 20:1 Analog, $I_{SD} < 1\mu A$, MSOP-16E
LT3755/ LT3755-1/ LT3755-2	High Side 75V, 1MHz LED Controller with 3,000:1 PWM Dimming	$V_{IN(MIN)} = 4.5V$, $V_{IN(MAX)} = 40V$, $V_{OUT} = 5V$ to 75V, 3000:1 PWM, 20:1 Analog, $I_{SD} < 1\mu A$, 3mm × 3mm QFN-16 and MSOP-16E
LT3756/ LT3756-1/ LT3756-2	High Side 100V, 1MHz LED Controller with 3,000:1 PWM Dimming	$V_{IN(MIN)} = 6.0V$, $V_{IN(MAX)} = 100V$, $V_{OUT} = 5V$ to 100V, 3000:1 PWM, 20:1 Analog, $I_{SD} < 1\mu A$, 3mm × 3mm QFN-16 and MSOP-16E